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HIGH CURRENT POWER CONTROLLER

P. E. McCOLLUM Author

ROCKWELL INTERNATIONAL AUTONETICS STRATEGIC SYSTEMS DIVISION 3370 MIRALOMA AVENUE P.O. BOX 4192 ANAHEIM, CA 92803

APRIL 1981

FINAL REPORT for period SEPTEMBER 1978 THROUGH DECEMBER 1980

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AERO PROPULSION LABORATORY AIR FORCE WRIGHT AERONAUTICAL LABORATORIES Air Force Systems Command Wright-Patterson Air Force Base, Ohio 45433

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This tecnnical report has been reviewed and is approved for publication.

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PREFACE

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This document is the final technical report for the High Current Power Controller Program. The work was performed by Autonetics Strategic Systems Division of Rockwell International, Anaheim, California under Air Force Contract No F33615-78-C-2202.

The work was administered under the direction of the Power Systems Branch, Aerospace Power Division, Aero Propulsion Laboratory, Air Force Wright Aeronautical Laboratories, Wright-Patterson Air Force Base, Ohio, by Mr. Duane Fox (POOS-2), Project Engineer.

C. E. Young of Rockwell International was technically responsible. Major contributions were made by C. O. Linder, P. E. McCollum, J. McGray, and W. A. McFall.

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нсрс	High Current Power Controller
SSPC	Solid State Power Controller
A	Ampere
I	Current
SCR	Silicon Controlled Rectifier
msec	Millisecond
mA	Milliampere
W	Watt
v	Volt
1b	Pound
Hz	Hertz
μΑ	Microampere
ZVC	Zero Voltage Crossing
ZIC	Zero Current Crossing
ADC	Analog to Digital Converter
MOSFET	Metal Oxide Semiconductor Field Effect Transistor
LSB	Least Significant Bit
in.	Inch
РСВ	Printed Circuit Board
MCMT	Mean Corrective Maintanence Time
MTBF	Mean Time Between Failures
DWV	Dielectric Withstanding Voltage
JFET	Junction Field Effect Transistor
EMI	Electromagnetic Interference
I ² t	Current (Squared) Times Time
CMRR	Common Mode Rejection Ratio
AMPS	Amperes
C00	Cost Of Ownership

SECTION I SUMMARY

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This report documents the High Current Power Controller (HCPC) development program performed by Autonetics Strategic Systems Division of Rockwell International. Aspects of the development covered by this report are basic HCPC concepts, design philosophies, fabrication techniques, and test results. Also included are reliability, maintainability, safety, and packaging considerations.

The HCPC program consisted of three phases, which were: Phase I, the preliminary design and breadboard study, Phase II, the development of the final designs, and Phase III, the fabrication, test and evaluation of the controllers designed in Phase II. The goal was to develop and deliver three of each type of HCPC: 10 ampere one phase, 10 ampere three phase, 50 ampere 3 phase, and 400 ampere 3 phase, all utilizing 115 volts, 400 Hz power.

Phase I activities included numerous trade studies and breadboard efforts to evaluate microcomputer performance, current sensing techniques, relay/contactor selection, volume, weight, and power dissipation.

Phase II consisted of refining the basic designs of Phase I with breadboard testing and design iterations with the goal of arriving at a common design core of electronics for use in any of the four configurations of power controllers.

Phase III, fabrication, evaluation, and test results, with problems encountered and appropriate solutions, provided confirmation of an acceptable design.

The major design activities of the HCPC program included: (1) the development of the microcomputer software for the timing, control, and trip functions, (?) selection of latching contactors with suitable current carrying capability and minimal size, (3) development of electrically isolated squaring current sensors, (4) development of a small efficient power supply and (5) packaging

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The primary design goal of the development of a controller incorporating the advantages of both solid state and electromechanical switches has been met, with the result being significantly less switching EMI than the electromechanical configuration and less power dissipation than the conventional solid state configuration.

SECTION 11

INTRODUCTION

2.1 Background

Aero Propulsion Laboratory sponsored development of Solid State Power Controllers (SSPCs) had previously emphasized current ratings of less than five amperes. Although higher current SSPCs have been developed, high power dissipation has been a major drawback. A hybrid configuration of solid state switches and electromechanical relays, the High Current Power Controller (HCPC) technique, combines the advantages of both technologies without the disadvantages of each, i.e. high power and limited life. The solid state element operates during the transition states of the switch - it applies power to the load at zero voltage crossing and removes power at zero current crossing, thus minimizing electromagnetic interference. It also limits the voltage across the opening or closing relay contacts to less than two volts, which prevents arcing across the contact and extends contact life. The relay is used to apply the steady state current to the load at a voltage drop and power dissipation approximately one tenth that of a solid state switch.

Rockweil, in late 1976 and early 1977, investigated the feasibility of using a Solid State Power Controller (SSPC) and electromechanical relay combination similar to the HCPC technique. That application extended power controller technology for requirements greater than 2 amperes while preserving the advantages of relays. The investigation indicated significant advantages in performance and potential cost reductions and served as a base for the HCPC program.

2.2 Objective

The objective of the HCPC program was to develop 115 volt, 400 Hz power controllers at current levels of 10, 50, and 400 amperes, using a combination of solid state and electromechanical switches.

2.3 Approach

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Rockwell's approach utilized the following primary electrical building blocks:

- A solid state switch with a low steady state voltage drop and high current carrying transient characteristics
- (2) Relays with high current capability and low contact resistance
- (3) Low power dissipation control and drive electronics
- (4) Low power dissipation load current sensors

The solid state switch was mechanized with silicon controlled rectifiers (SCRs). A digital microcomputer with a multiplexed analog-to-digital converter (ADC) provided the control and trip functions. A current shunt, coupled with a modulator/demodulator type sensor circuit, was used for load current sensing.

This approach paralleled the original proposed mechanization with the exception of the load current sensing technique. A Hall Effect current sensor was tentatively proposed but was discarded based primarily on its large size and its output variations with temperature.

General packaging considerations included volume, thermal dissipation, and cost. The proposed technique for the control electronics assembly or electronics module envisioned joining NMOS and hybrid thin/thick film technologies. Although this approach utilized minimum volume, its disadvantage was its greater cost. An approach using a discrete component mechanization that retained the module technique was found to meet all volume requirements and was more cost effective.

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SECTION III TECHNICAL DISCUSSION

3.1 Mechanization/Design

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3.1.1 HCPC Configuration

The configurations selected by Rockwell for mechanization of the High Current Power Controllers are shown in Figure 1 and 2. The addition of current limiting resistors in series with the mechanical contacts and the substitution of a modulator/demodulator type of current sensor is a modification of the configuration originally proposed.

Current limiting resistors aid in diverting load current to the SCRs in the event of an overcurrent condition.

Analysis of the various methods of load current sensing available inaicates that a modulator/demodulator type of sensing circuit offered overall advantages in size and was determined to be less of a design risk.

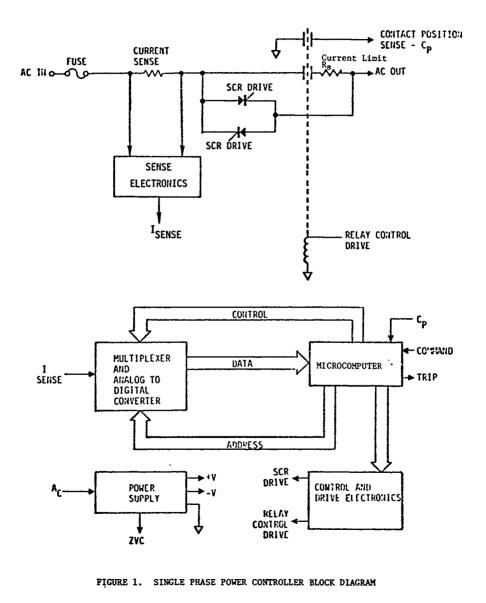
3.1.2 Primary HCPC Circuit Elements

The primary elements developed or selected were as follows: (see Figures 1 and 2):

- Microcomputer with appropriate software for the trip and control functions
- (2) A small, electrically isolated, high current sensor
- (3) Solid state switch with suitable high current transient characteristics
- (4) Latching mechanical contactors with high current capability
- (5) Low power switch drive electronics
- (6) Low resistance fuse for the 10 ampere configurations
- (7) Small, efficient, electrically isolated power supply

The four basic modes of operation are: (1) Normal turn-on, (2) Steady state on,

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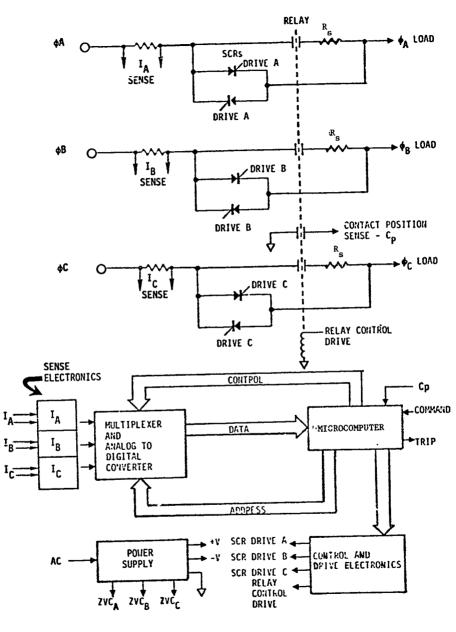
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CONTRACTORY AND DRAFT

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FIGURE 2. THREE PHASE POWER CONTROLLER BLOCK DIAGRAM

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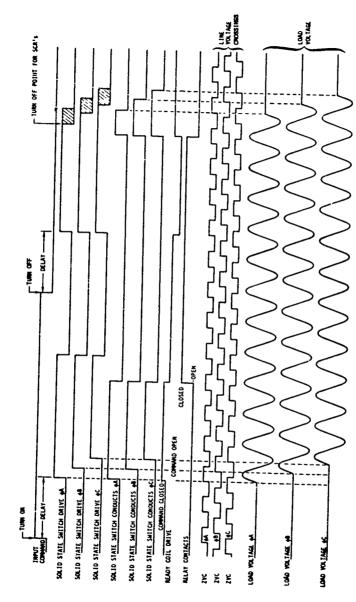
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(3) Normal turn-off, and (4) Overcurrent based trip. In each mode the microcomputer performs a monitor and control function to insure that the relay is provided with a maximum of protection.

A "normal" operation of a three phase controller, assuming a normal turnon with a period of steady state on time, followed by a normal turn-off, includes the following sequence of events: upon receipt of a +5 volt signal on the control input, the microcomputer begins counting ZVC pulses, while monitoring the control input. If the control input remains high for 2.5 to 5.0 milliseconds, (1-2 ZVC pulses) the microcomputer initiates the turn on sequence shown in Figure 3. First, each pair of solid state switches controlling a phase is turned on at that phase's next zero crossing, establishing power to the load. In conjunction with the SCR drives, the relay is commanded on. After the relay latches on, the solid state switches are turned off, and steady state monitoring for an overcurrent or a turn off command begins. The microcomputer samples the current in each phase, via the analog-to-digital converter, every 200 microseconds. The current data is then processed using an I^2t trip algorithm, which results in a trip if an overcurrent is present. However, the steady-state-on period is normally terminated by a turn off command. When a turn off command is received, the solid state switches are turned on, the relay unlatched, and then the switches cycled off such that the load voltage is removed on the same slope as turn on occurred.

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Overcurrent based trip can occur by either of two means. If the overcurrent is greater than 100 percent but less than 1000 percent (100 to 250 percent for the 400 ampere controllers) of rated load, a timed, or I^2t trip results. If an overcurrent of great magnitude (greater than 1000 percent) is sensed, an instanteous trip is initiated. In either case, once a trip state is initiated, the solid state switches are turned on, the relay latched off, and subsequently the switches turned off immediately. However, if the controller is commanded on into the large fault, having been in the off state, the relay is not allowed to turn on. In that case, the load would only experience a single half cycle of that load voltage.



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3.1.2.1 Microcomputer and Analog to Digital Converter (ADC)

A Rockwell International Model 6500/1 microcomputer and a National Semiconductor ADC (ADC 0808) were selected to perform the digital processing. The Rockwell International microcomputer replaced the Intel Model 8748 originally proposed due to superior processing speed and extensive in-house development aids.

3.1.2.1.1 Trip Mechanization and Control Functions

Considerable time and effort was expended in devising the trip algorithm and developing the software for the HCPC control and trip functions. The algorithms evaluated were:

(1) Accumulator $n = Accumulator n-1 + I^2$ for I> minimum trip

=Accumulator $n-1 - I^2$ for I< minimum trip and

Accumulator n-1 >(minimum trip)²

- (2) Accumulator $_{n}$ =Accumulator $_{n-1}$ + I² (minimum trap)² In algorithms 1 and 2, the power controller will trip if the Accumulator is greater than a fixed value.
- (3) Trip time is based on $I_{n-1}^2 I_n \times I_{n-2}$ being greater than a time specified by a lookup table. This algorithm requires a sample rate above 10 samples per cycle on each phase, but it permits the use of a trip time-current characteristic curve of any shape.

Algorithm No. 2 was selected as the preferred method to mechanize the trip function. This algorithm provides for the same computations to be made on each sample of the load current rather than the multi-decision mechanization of algorithm No. 1. Algorithm No. 3 requires a higher sample rate of the load current and the variable trip characteristic feature provides no advantage when the only trip response required is an I^2t curve.

Early work included the evaluation of the advantages and disadvantages of squaring I in the microcomputer compared to providing an I^2 output from the sensor to the microcomputer. The study concluded that the microcomputer could accommodate either method. However, the subcontractor developing the current sensor indicated

that higher accuracy could be attained with a squared output rather than a linear output. The decision was made to perform the squaring in the sensor.

Figure 4 is a flow chart of the software developed and is identical for all four HCPC configurations. The software includes the capability of being scaled for any of the steady-state currents of 10, 50 or 400 amperes and can accommodate either a one phase or a three phase configuration.

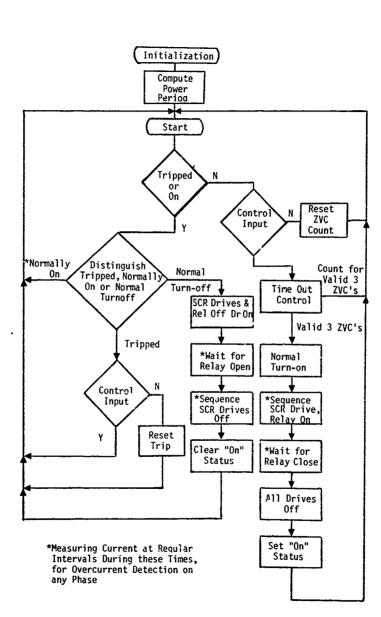
The use of a microcomputer provided flexibility and programability to the HCPC design. Programmable selection of HCPC full scale current, which is achieveable by digital code selection, will change (1) the fast trip point, (the high current that causes an immediate trip), (2) the first trip point (the minimum current that will effect a trip), and (3) the constant value to which the accumulator is compared (this provides the shape and slope of the trip response curve). The zero voltage crossing (ZVC) is derived by the ZVC circuits for Phase A and used b' the microcomputer to turn on the Phase A SCRs and to derive the turn-on times for Phase B and C.

A simila- technique is used to develop the timing for Zero Current Crossing (ZIC). Phase A SCR gate drive is turned off at Phase A negative voltage maximum and the microcomputer then times the Phase B and C gate turn-off points based on :he Phase A maximum.

A turn-on a d turn-off delay of 2.5 to 5 msec, (1-2 zero voltage crossings) in response to a change in the Control Input signal, has been incorporated into the timing sequence to reduce the sensitivity of the Control Input to noise transients.

The auxiliary contact of the mechanical switch is used to provide relay status (open or closed) to the microcomputer.

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3.1.2.2 Load Current Sensor

A shunt current sensor approach was selected as the technique to sense the magnitude of the load current. This represents a change from the Hall Effect current sensor originally selected. The Hall Effect sensor technique was discarded as an approach because of its larger size and the drift with temperature. Two current sensor suppliers were contacted and asked to quote to a general set of requirements. One of the suppliers responded verbally, stating that the size limitations could not be met and that they did not wish to expend further effort. The other supplier submitted a quotation to include preliminary drawings and cost. The 50 and 400 ampere designs were within size constraints; the 10 ampere design size was not.

Quote on 50 Amp Sensor (Magnetics Only):

Current Range	0 to 1760 Amps
Size	1.5 x 1.5 x 0.5 inches
Linearity	3 percent
Offset	<u>< 16 mV</u>
Offset Draft	40 μ V/°C
Frequency Response	< 5 percent accuracy,
	DC to 400 Hz

The sensor design selected makes use of an HCPC internal conductor as a resistance element for current sensing. The material selected for the conductor is manganin, a copper alloy that was chosen for its very low temperature coefficient of resistivity. The voltage across the element is thus directly proportional to line current for all values of temperature within the required operating range.

The characteristics of the manganin with respect to temperature or current will directly affect the operation of the total sensor circuit. The relevant characteristics have been analyzed and are listed in Table 1.

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TABLE 1.

MANGANIN CHARACTERISTICS

Rated Current	Resistance (Ohms)	Peak Current	Power Dissipation at Rated Current	Fusing Time at Peak Current
10A	0.005	423A	0.5 W	0.89 sec
50A	0.001	2121A	2.5 W	0.89 sec
400A	0.000125	4383A	20 W	13.3 sec
L				

The temperature characteristics of sample pieces of manganin were confirmed by laboratory tests. The results are shown in Table 2.

TABLE 2.

MANGANIN RESISTANCE VS TEMPERATURE TEST DATA

	1 _	1		
Temperature	Resistance	Percent	Resistance	Percent
(deg C)	Ohms (1)	Error	Ohras (2)	Error
-55	0.00450	-0.9	0.00749	-0.8
-34	0.00452	-0.4	0.00750	-0.7
-17	0.00452	-0.4	0.00755	0
0	0.00454	0	0.00755	0
+17	0.00454	0	0.00755	0
+35	0.00456	+0.4	0.00755	0
+75	0.00454	0	0.00755	0
+100	0.00454	0	0.00755	0
+125	0.00454	0	0.00755	0
		1		

(1) $\approx 0.05 \times 0.4 \times 6$ inch sheet sample

(2) ≈0.09 x 0.12 x 5 inch rod STO 0170AB0045 Type II

The voltage across the manganin is modulated at a 35 kHz rate, passed through a transformer for isolation, then through a squaring amplifier for gain and demodulation. The signal is then filtered and supplied to the ADC for digitizing. The squaring isolation amplifier general characteristics are in Table 3.

Function:	$v_{o} = 8.26 (v_{in})^2$
Accuracy:	2% of point or 2 mV (whichever is greater) dc to 400 Hz
Isolation:	1000 Vrms
CMRR:	>100 dB
' Range:	0 to +5 volts
Power:	\approx 0.150 Watt at \pm 15 Vdc
Size:	1.4 x 1.1 x 0.475 in. (may be further reduced)
Packaging:	Hermetic high permeability nickel alloy case with glass pin seals

TABLE 3 SQUARING ISOLATION AMPLIFIER DATA

This sensor was selected on the basis of its high accuracy over the operating temperature range. Tests of the sensor confirmed the quoted accuracies at room temperature. Table 4 shows the complete test data.

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TABLE 4

TEST DATA ON

SQUARING ISOLATION AMPLIFIER

DI LOL	0.0	0.0	0.0	C.1	0.2	0.34	1.5	7.5	10.5	25	
V. Error	2.065 2.065	2.065	2.063	2.062	2.060	2.058	2.033	1.961	1.847	1.554	
-											<pre><2 mV with 115 Vrms applied to both input terminals. 0 to + 8.1 Vpk Out</pre>
at 0.5 Vrms Input	DC 100	200	300	400	200	1000	2000	4000	6000	10000	lied to both
Fercent Error	0.0	1.5	1.7	0.3	0.5	0.2	0.1	0.0	0.1		115 Vrms app Vpk Out
Expected Vo	0.000	0.0207	0.0826	0.3304	0.7434	1.322	2.065	2.974	4.047		2 <1 mV <u>Rejection</u> <2 mV with 115 Vrm <1.7% error, 0 to + 8.1 Vpk Out
Average Vout	0.000	0.021	0.084	0.331	0.747	1.319	2.062	2.973	4.050		<u>Output Noise</u> <1 mV <u>Common Mode Rejection</u> <u>Linearity</u> <1.7% error
V _{in} (rms) at 400 Hz	0.00	0.05	01.0	0.20	0.30	0.40	0.50	0.60	0.70		Output Noise Common Mode I Linearity

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3.1.2.3 Solid State Switch

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A Silicon Controlled Rectifier (SCR) was the selected solid state switch for the HCPC application. For the 10 ampere configurations, the Motorola 2N6507 was selected to replace the originally proposed Unitrode LISR05554F, due to the cancellation of the entire Unitrode line of "Chipstrate" devices. The SCRs for the 50 and 400 ampere applications have been changed to the Semikron SKKT 90 from the General Electric C380x500. The Semikron devices are prepackaged in thyristor-modules as opposed to the "hockey-puck" configuration of the General Electric SCRs that require bulky pressure clamps and isolation techniques. The Semikron devices were found to be superior in utilizing volume while still meeting the electrical requirements. For the 400 ampere application, two SKKT 90 were paralleled for each half side of conduction required, giving a total of four SCRs per phase. Series resistors are included in each SCR leg to force current sharing in event that any mismatch in the forward voltage drop of any SCR could cause current "hogging". Table 5 lists the critical SCR parameters.

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TABLE 5

	CONTROLLER USE						
PARAMETER	10A, 1 & 3 Ø		50A, 3 Ø		400A, 3 Ø		
	Req.	2N6507	Req.	SKKT 90	Req.	SKKT 90(2)	
Blocking Voltage	>254V	400V	>254V	400V	>254V	400V	
RMS on Current	10A RMS	25A RMS	50A RMS	145A RMS	400A RMS	290A RMS	
Fault Current (from Table 6)	225 A	400 A	1400 A	2000 A	2C00 A	4000 A	
Leakage Current	l mA	4 mA	1 mA	4 mA	5 mA	8 mA	
di/dt (non- repetitive)	lA/µs	<u>></u> 10A/µsec	5A/usec	100A/µsec	12.5A/µsec	200A/µsec	
dv/dt (Circuit)	690V/usec	<u>≥</u> 50V/µsec	690V∕µsec	500V/µ£⇔c	690V/µsec	500V/µsec	

SCR PARAMETERS

The dynamic resistance of an SCR (RSCR) was one of the key characteristics in the selection of the HCPC SCRs. Consider Figure 5:

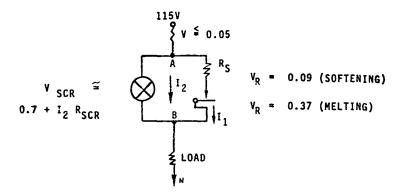


Figure 5. Relay - SCR Current Sharing

To prevent arcing across the relay contact, the voltage across the latter must be less than 12 volts. This is no problem at steady state turn-on, since the voltage from A to B will be less than 2 volts. At turn-off, with the relay contact closed, and $V_R \leq 0.1$ voit, the SCR will assume the steady-state current as the relay contact opens and clamps the voltage from A to B at less than 2 volts. In the contact closed condition and with a large sudden over-current, opening the relay contact (tip condition) with the SCR closed could possibly overheat the contacts if the current was not limited through the contact. The resistance R_S has been added to increase the voltage drop across the contact section and let the SCR assume a share of the overcurrent.

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The SCRs selected are shown in Table 6.

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Table 6

SCR SELECTION								
Configuration	Specified Rupture Current	I _l (Relay)	1 ₂ (SCR)	Condition				
10A	400A	175A	225A	$v_{\rm R} \leq 0.3 v$ $R_{\rm SCR} \leq 0.008 \Omega$ 2N6507				
50A	2000A	600A	1400A	v _R ≤ 0.3V R _{SCR} ≤ 0.001Ω SKKT 90				
400A	5000A	3000A	2000A	$V_{R} \leq 0.3V$ $R_{SCR} \leq 0.0005\Omega$ (2) SKKT 90				

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The leakage current of the SCRs sized for HCPC current levels exceed the HCPC specified maximum. A study by Dalziel and Lagen in the March 1941 issue of <u>Electronics</u> titled "Muscular Paralysis Caused by Electric Currents" found that 97.5 percent of their test population could release a 12 mA rms, 400 Hz sinusoidal current and a 10 mA rms, 60 Hz sinusoidal current. Selection of the 10 ampere SCRs for minimum leakage current would probably reduce the total leakage current to 4 mA, still in excess of the 1 mA HCPC requirement, but appreciably below the 12 mA muscular paralysis level.

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The possibility of reducing the 50 and 400 ampere SCR leakage current levels to below 5 mA by selecting SCRs is very low. Consequently, other methods were considered. These included (1) grounding the HCPC output when not connected to the aircraft load, (2) providing a resistive path to ground, (3) using a "make-make" contact relay. This would have to be a specially designed relay that would have one set of contacts in series with the solid-state switch in addition to the load current contact. The SCR would close at a time between the "make" of the two contacts (the contact in series with the SCR would close first); the sequence would be reversed on opening. The possibility of having such a relay designed has not been explored, but it is expected to be more expensive than the presently selected relays and contactors.

Providing a resistive path to ground for the leakage current was selected as the most economical and easily mechanized approach. To minimize power dissipation, a positive temperature coefficient resistor is connected from the HCPC output to ground. The resistor provides a path of approximately 100 ohms to ground when the HCPC is "off" ($V_{out} = 0$), but when the HCPC is "on" ($V_{out} = 115V 400 \text{ Hz}$), the effective resistance of the resistor exceeds one megohm. This approach effectively shunts away current for the no load off or high impedence load condition, minimizing the potential shock hazard.

3.1.2.4 Relays and Contactors

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Selection of suitable mechanical switches for the HCPCs was preceded by a detailed analysis of switch contact characteristics. As probably could have been anticipated, the primary characteristics of concern is contact temperature. Overheating (and consequent contact deterioration) is due to excessive current, arcing,

or high contact resistance. Accordingly, the contact size must be matched to the maximum steady-state current. The contact resistance is kept low by selecting contact material with high conductivity and by providing sufficient contact pressure. The effects of arcing are minimized by opening the contacts rapidly and by using metal alloys developed for such applications.

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The great majority of all relays and contactors in the 10 to 400 ampere class use silver cadmium oxide as the contact material. The softening voltage of this material is 0.09 volt and the melting voltage is 0.39 volt. The current limiting resistance values in the HCPCs, in conjunction with the SCRs, are designed to limit the contact voltage at approximately 0.3 volts, or below the melting voltage. No other material offered significant additional advantages. Consequently, silver cadmium oxide was the contact material selected.

In the area of overcurrents, relay and contactors generally are able to withstand rupture currents (and still open) of approximately 10 times rated current. However, the same devices can withstand higher overcurrents for the circuit breaker compatibility condition (withstand current, contact is not required to open). In HCPC usage, the SCR assumes varying amounts of the over currents, thus, larger overcurrents can be tolerated in the HCPC configurations compared to pure relay applications.

Leach relays, types JDL and KDL, were selected for the 10 ampere configurations, respectively, based on their size, maximum steady-state current rating, and circuit breaker compatibility. Two KDLs connected in parallel was the choice for the 50 ampere HCPC for the same reasons. The Hartman B-382 was selected for the 400 ampere configuration.

An analysis of the mechanisms involved with the operation of electrical contacts demonstrated some of the advantages of augmenting the electromechanical contacts with a solid state switch. Typical militarized power contactors are designed to limit the steady state temperature rise of the power input and output terminals to 65° C above the maximum rated ambient temperature. The primary source of heat is the I²R power dissipated by the contacts where R is the resistance of the closed contacts and I is the load current. The magnitude of

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R is maintained at sufficiently low values by providing sufficient contact pressure, large enough contacts, and low resistance terminal-to-contact wiring.

Designing for a satisfactory contact life requires additional design considerations. Long contact life requires that the contacts are not consistently overheated when closing or opening, to prevent temporary melting and subsequent erosion of the contacts. In addition to the heating of a closed set of contacts due to I²R, the contacts are also heated due to arcing when opening. It is convenient to express this heating as caused by VIt, where I is the current through the contact, V is the voltage across the contacts and t is equal to the time the contacts are arcing. For this discussion, assume a resistive load. The magnitude of V for an opening set of silver cadmium contacts varies from a value of approximately 0.4 volts (the melting voltage) for the closed, but now opening contacts, to a value equal to the supply voltage while the contacts are arcing. The arc is extinguished when the contact separation is sufficiently large or the voltage or current drop below the minimum values that will sustain an arc (approximately 12 volts for silver cadmium). The majority of military power contactors are used with DC, or with 60 Hz or 400 Hz as the supply frequency. The following conclusions can be drawn:

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- Since the voltage impressed across an opening set of contacts is instantaneously the rated supply voltage, a DC application of a contactor would be more severe on contact life compared to the cyclic 60 and 400 Hz amplitudes
- (2) The 60 Hz application is more severe than the 400 Hz, since tag $\frac{1}{2f}$

Typical electromechanical power contactors achieve the necessary contact life (for given contact materials) and normal steady state maximums by:

- Providing "double break" contacts; this doubles the distance the switched voltage must arc, thus allowing larger voltage ratings for given contact travel
- (2) Rating the contacts as a function of the frequency of the switched voltage and switched voltage V maximum. The 65°C temperature rise limitation of the terminals determines the maximum current rating.

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Since the solid state switch in an augmented power contactor limits the voltage across the making or breaking contacts of the electromechanical contactor to less than two volts, arcing will not occur. Thus the above design considerations required to extend contact life for electromechanical contactors are not required for the augmented configurations. The result is that physically smaller contactors could be used in the latter configurations compared to electromechanical units. For example, the Hartman B-241 DM contactor is rated for 350A (resistive load) at 115/200V, and 125A at 264/458V 400 Hz. Used in an augmented circuit, the contactor could operate with 350A at 264/458V, 400 Hz. The Hartman B-382 is rated at 120A, 120/208V at 60 Hz and at 200A for both 60 and 400 Hz. It is estimated that contactors used in an augmented type of AC circuit could be at least 30% less in weight and volume than their electromechanical counterparts, assuming the same voltage, frequency and current.

It would appear that high voltage PC controllers would benefit most from eliminating the heating caused by EIt or arcing. However this apparent advantage may be negated in whole or in part by the additional circuitry that would be needed to provide the extra transistor base or gate drive when the solid state switch is required to divert nigh rupture currents.

A contactor could also conceivably be redesigned to be a single break contact type and theoretically double its current carrying capacity, without changing its physical size. The Hartman B-382 is rated for 200A at 400 Hz and uses double break contacts for each phase. The HCPC technique allows the two series contacts to be connected in parallel and thus conduct 2 x 200A of current. The modification is shown in Figure 6. This modification or equivalent is necessary to meet the weight and volume requirements of the 400A production configuration.

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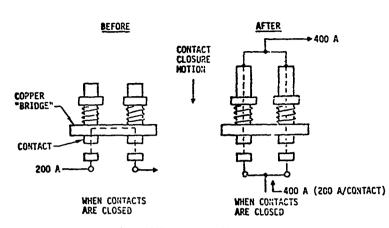


Figure 6 B-382 Contact Modification

This change assumes that the wiring to both sides of the two pairs of contacts (two parallel input lines and two parallel output lines) is sized to conduct 200A through each contact pair, or 400A total. This change also assumes that i.e weight of the additional wiring on the moving half of the contacts (fle ible, suspended, welding cable could be used) will not seriously impair the opening or closing action or operating time of the contacts. Since the solid state switch applies power to the load in the first positive cycle (1.25 MS for 400 Hz), and waits for the relay to close, slowing down the parallel connected contacts slightly does not appear to be a serious drawback.

3.1.2.5 Switch Drive Electronics

The SCR Drive Circuit selected uses 50 kHz, transformer coupled power from the HCPC P₁ or Supply and is controlled through optically coupled devices. The use of line t_c. rive power as originally considered, consumed too much power. A drive circuit similar to the one used for B-1 solid state power controllers was developed and used on the 10 ampere breadboard configuations; however, the large number of parts required ruled out this approach.

The drive circuit was designed to accommodate a wide range of SCR requirements. By the selection of a resistor, drive current can be varied from 0 to 150 milliamperes. In addition, a JFET provides a low impedance resistance path from gate to cathode during the off state, to prevent dv/dt degradation due to SCR leakage.

3.1.2.6 Fail Safe Fuse

The fuse concept developed by Autonetics for its 2 ampere solid-state power controllers was used to generate the 10 ampere design required. In addition to the requirement to clear at above 10 amperes, the maximum fuse resistance was set at 10 milliohms to correspond to a fuse voltage drop of 0.1 volt, maximum. Since the 2 ampere fuse was two series elements with a total resistance of approximately 70 milliohms, the 10 ampere fuse was initially conceived as consisting of a number of parallel 2 ampere sections to reduce the resistance. Tests of seven 2 "mpere, two-section fuses connected in parallel indicate that such a combinati "ears in 10 seconds at 40 amperes. This clearing time is within the planned ful learing area. The next step was to combine the electrical properties of the seven elements into one composite element. This was accomplished and verified by test. Figure 7 illustrates the design concept.

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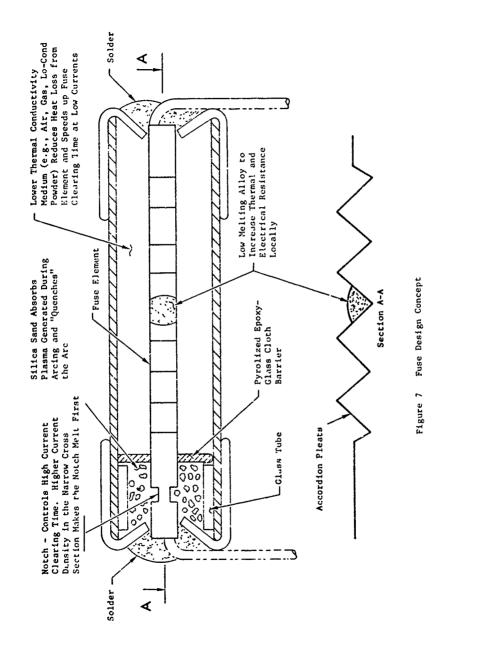
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3.1.2.7 Power Supply

The power supply is a multiple output flyback AC-to-DC converter operating at 50 kHz. Regulation is accomplished by pulse-width-modulated drive to a MOSFET switch that controls the rectified and filtered 400 Hz voltage. Pulse width modulation is based or voltage/current information received via a separate feedback winding that also supplies power to the switching regulator control IC. The multiple outputs provide isolated SCR drive and four levels of voltage (+ 28 Vdc, + 15 Vdc, -15 Vdc, and + 5 Vdc) for use by the control electronics.

The control IC and the drive electronics for the MOSFET power switches are initially bootstrapped into operation with the incoming line power until the feed back-winding-derived power approaches the regulation point. The bootstrap supply is then turned off and normal steady state operation begins. The power supply provides approximately 2.0 watts with 85 percent efficiency during steady state operation.

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3.2 Packaging

The final package designs for the four types of HCPC configurations were the result of a lengthy progression of design interactions centering primarily on minimum volume and cost. Several of the primary design considerations included the following:

- (1) Standard modules for the common electronics
- (2) Standardized off-the-shelf drawn metal enclosures
- (3) Standard module size for ease of repairability/maintainability
- (4) Fotting material for sealing and to provide rigidity

The final package configurations are expected to meet all the design criteria for minimum volume, lowest cost, vibrational and shock characteristics, electrical isolation, and efficient thermal dissipation. The steps taken to arrive at the final designs will be described in the following sections.

3.2.1 Packaging Detail

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End item designs evolved through modification of Phase I packaging concepts, which proposed using three methods to assemble the HCPC components:

- Two-sided printed circuit board (PCB) modules mounted to the insides of the enclosure housings
- (2) Subassemblies mounted to the base of the housings
- (3) The sense resistors, fuses, and power input terminals mounted on the inside of the lids of the controller enclosures

However, these concepts were found to be volumetrically inefficient after electrical design and parts evaluations were finalized. Further packaging studies conducted subsequent to a first cut layout of the module projected to the most dense indicated a more efficient approach would be to: (1) standatdize the size and contents of the PCB modules to the furthest degree, and (2) mount the components projected for the lid on the PCBs.

The need was established for the PCBs of three major types:

 An AC to DC power supply module including a power transformer and the zero voltage crossing detection circuits (See Figure 8) as no bet a creat in the second

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- (2) A microcomputer/ADC module containing the control and timing circuitry (See Figure 9)
- (3) The SCR drive module that provided drive to one pair of solid state switches. One of these modules is required per phase (See Figure 10)

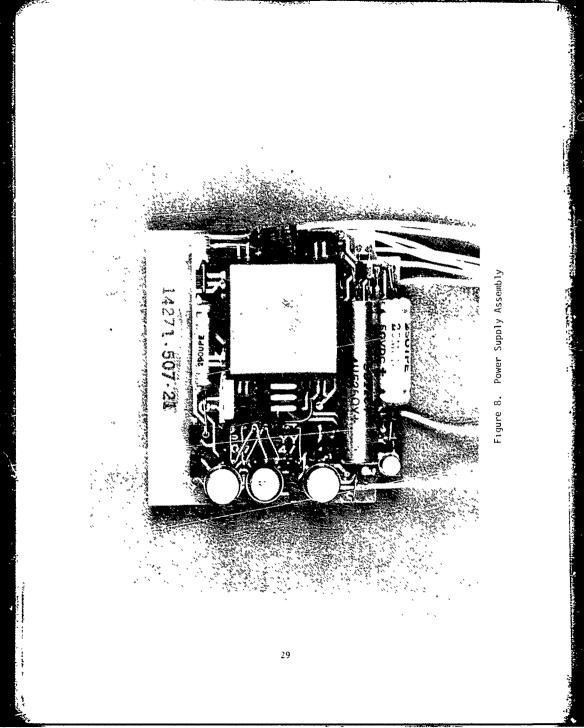
Careful consideration was given to PCB design aspects such as circuit current carrying requirements, line spacing for voltage isolation, the system grounding scheme, and minimum volume utilization. Once an optimization of the PCBs was completed, packaging them in a metal enclosure was addressed.

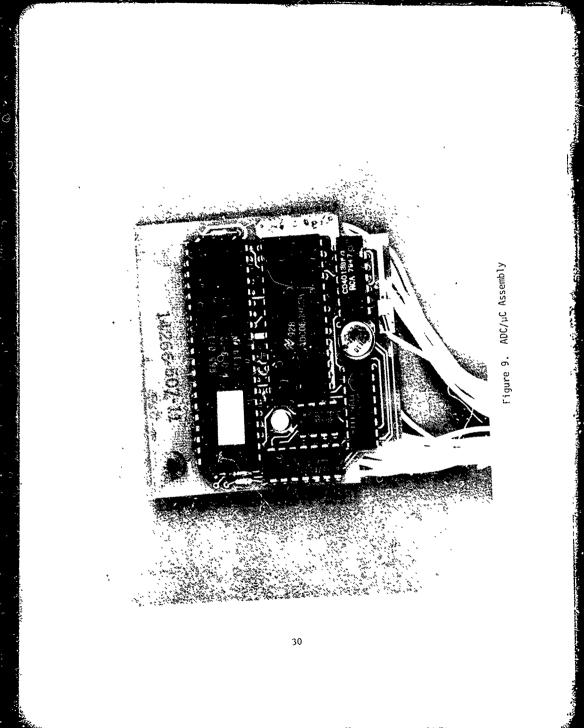
Original plans for the metal enclosure included a cast or brazed housing with machined metal lid and an RF gasket seal. However, this concept presented the following disadvantages:

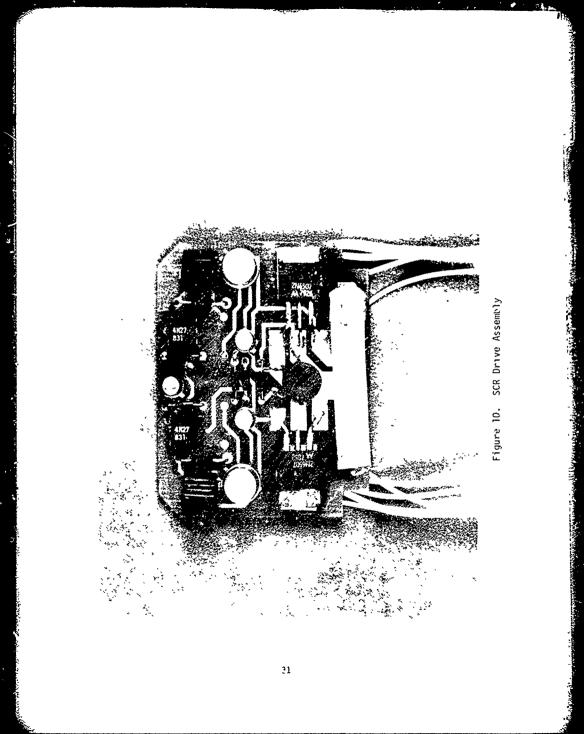
- Large size; due to the need for additional internal board support, mounting flanges or module guides were required.
- (2) Large wiring service loops required for tinal module integration
- (3) Insulation requirements around terminals projecting through the metal cover
- (4) Large costs associated with machining requirements

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After evaluating possible alternatives, the decision was made to use a standard deep-drawn can, a metal screen for an RF shield, and thermally conductive potting material to hold the modules and screen in place and dissipate heat. The decision to use potting material eliminated the need for heavy metal heat sinks and/or module guides, increased electrical isolation within the enclosures, and enhanced vibrational and shock characteristics. Coupled with a standard drawn can approach, virtually all the costly machining for the metal lid and housing was eliminated.







Two different types of potting were planned for prototype and production use: a "soft" (RTV 511 Silicone) filler for the prototypes and a "hard" cap (Scotchcraft 281 epoxy) for production usage. Production controllers would not be filled with the soft material due to the large weight penalty, but just "capped" to provide the required environmental seal. The cap would consist of approximately one quarter to one half an inch of potting material at the top of the enclosure. Filling the prototypes with just the soft potting provided an ease of repairability. Figures 11 - 15 illustrate the packaging methods for the four configurations. Table 7 summarizes the final enclosure dimensions, volumes, and weights. Table 8 contains the breakdown of the various component weights.

Table 7

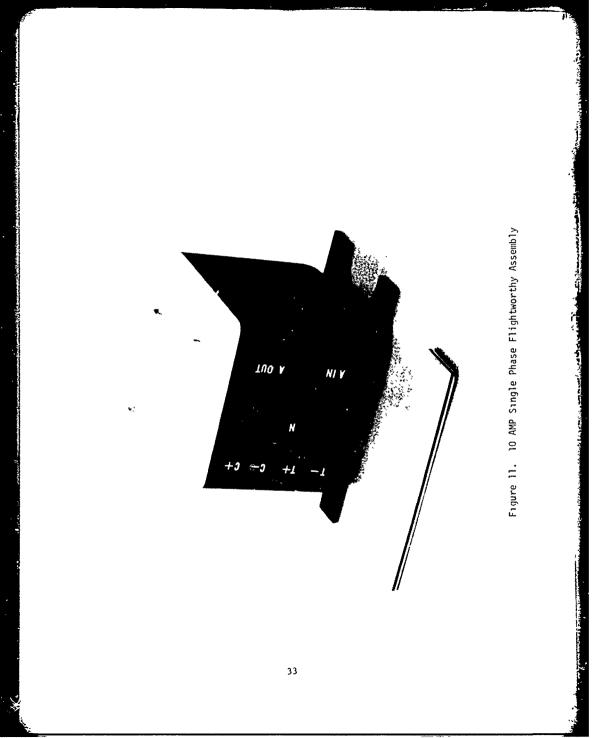
Summary	of	Enclosure	Dimensions

CONFIG.	DIMEN: (INC)		VOLI (CU II	UME NCHES)	WEI (POU	
	SPEC	UNIT	SPEC	UNIT	SPEC	UNIT
10A 1Ø	2.3x2.5x2.6	2.31x2.5x2.63	14.95	15.17	3.2	1.06
10A 3Ø	2.3x2.6x4 2.31x2.75x4.5		23.92	28.61	1.9	1.927
50A 3Ø	2.3x4.4x6.4	.4x6.4 2.3x4.4x6.4		64.77	4.3 4.59	
400A 3Ø	4.5x4.6x10.5	4.5x4.6x10.5	217.35	217.35	15.7	15.69

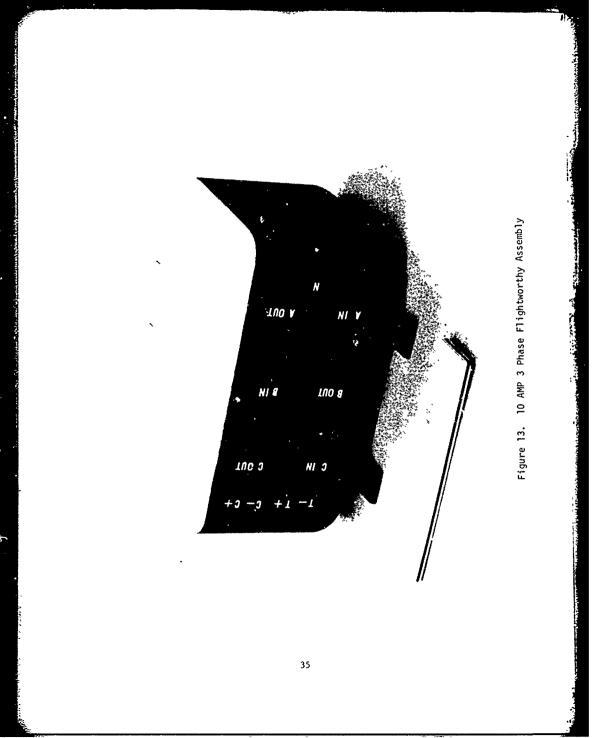
The 50 ampere, three phase and 400 ampere, three phase controllers were packaged and delivered in brassboard configurations that were designed to be as close to production configurations as possible. All the PCBs are mounted to a metal base using L-shaped brackets, with the current sensing subassemblies and the relays directly mounted to the base. Layout of the various subassemblies, modules, and components was done with the same considerations given to production design, such as minimum wire service loops, terminal spacing requirements, etc. A cooling fan was added to each of the 400 ampere controller brassboards to compensate for the thermal dissipation capabilities lost from the production design by the absence of thermal potting material and metal enclosures.

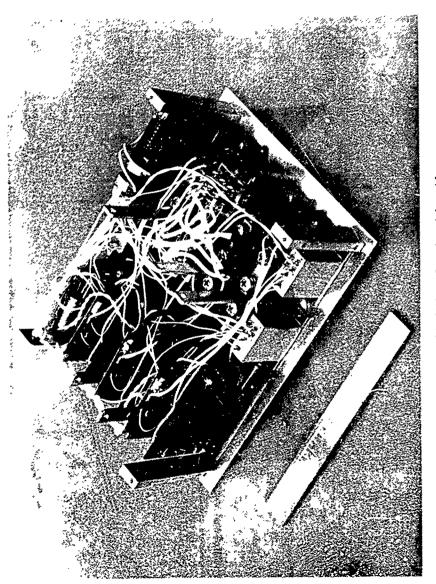
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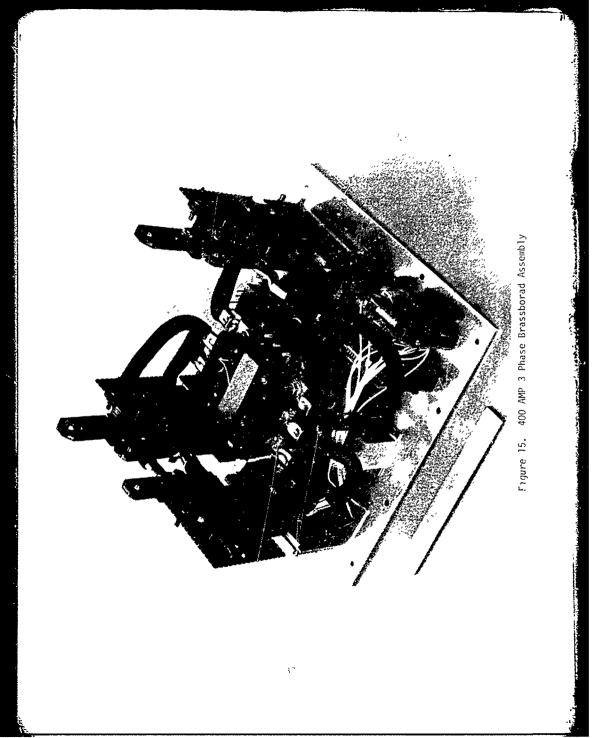








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TABLE 8

WEIGHT BREAKDOWN

	1Ø - 10A	3Ø - 10A	3 9 - 50A	3Ø - 400A	
Relay	*0.073	*0.146	0.292	3.0	
Sensor	*0.06	*0.18	0.18	0.18	
Terminals	on boards	on boards	0.226	0.913	
SCR BD(s)	*0.065	*0.195	0.144	0.108	
SCR '	-		1.056	3.3	
Wire i	0.002(Est)	0.002(Est)	0.046	1.006	
Sense Resistor	on board	on board	-	0.618	
Power Supply	*0.180	*0.180	0.184	0.184	
ADC/µp	*0.065	*0.065	0.07	0.07	
Chassis	*0.145	*0.185	0.432	1.004	
Mrg Screws	on chassis	on chassis	0.034	0.068	
Potting	0.47	.973	1.928(Est)	5.24(Est)	
TOTAL (Pounds)	1.06	1.927	4.59	15.69	

*These weights were updated to reflect current actual weight of completed components. The 50/400 ampere weights were not updated, since completed components reflect the brassboard configurations, which are heavier than the above flightworthy configurations.

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3.2.2 Assembly Problems

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Difficulties in the actual assembly of the controllers, that are common to all configurations, were manifested most fully in the 10 ampere, three phase controllers, resulting in a change from the originally chosen can size.

The original can size for the three phase 10 amperc unit was selected based on component heights and volumes in the basic design. The can size selected was $2.32" \ge 2.65" \ge 4.00"$ and was calculated to be sufficient to accommodate the components, boards and wiring. However, following the fabrication and assembly of the modules and the assembly of the units, the total length of the unit exceeded the 4.00 inch dimension by approximately 0.2 inches. Closer examination revealed several contributing areas of dimensional build-up.

- The fuse end caps caused the height of the fuses above the boards to be .050 inches higher than planned
- (2) The height of the transformer was .100 inches over the planned dimension
- (3) The height of the capacitors was the maximum dimension rather than the planned nominal dimension
- (4) The crystal configuration required two insulators for spacing as opposed to one, thereby increasing the overall height
- (5) Due to wire routing over components, additional packaging space was taken

The larger can was also thicker gauge metal, resulting in more outside volume and more weight. The larger can required more potting, hence additional weight. Further refinement of individual component placement and design would result in optimization of can size.

As a final note regarding assembly, the capability for repairing a unit potted with the soft material was verified toward the final part of the program. Two units were returned from the potting area in a non-operating mode. The external metal housing was cut away and the soft potting material carefully picked apart in the suspected trouble area. A broken wire was repaired and a short removed. The units were then repotted in new metal enclosures. Retest verified correct operation.

3.3 Test Results

Tests were conducted in accordance with the approved Test Plan (Appendix A) to verify the basic functional operation of each unit delivered. Two units of each type were tested for delivery.

3.3.1 Basic Functions

The following tests were chosen from the Test Plan as basic functions for a high current power controller:

- (1) Turn On/Turn Off Times
- (2) Trip Out Time
- (3) Overload Trip Indication
- (4) Output Voltage Drop
- (5) Zero Voltage Turn On/Same Slope Turn Off
- (6) Power Dissipation

A brief description of each test is included in the following sections, together with the test results. Generalized results are listed in Table 9.

3.3.1.1 Turn On/Turn Off Times

3.3.1.1.1 Test Requirement

The turn-on response requirement was identical for each configuration and was 1^r milliseconds maximum. The turn-off response was required to be 20 millisecor is maximum for the 10 ampere and 50 ampere controllers, while the 400 ampere controller was allowed a maximum of 30 milliseconds. Turn-on time was measured from the application of the minimum turn-on control signal to the receipt of AC power to the load. Turn-off time was measured from the application of the maximum turn-off control signal to the removal of AC power to the load.

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TEST NAME	10,	A 1Ø	10A	3ø **	50/	A 3Ø	400A 3Ø	
	S/N 001	S/N 002						
TURN ON/OFF TIMES	PASS							
TRIP OUT TIME	PASS	PASS	PASS	PASS	FAIL	PASS	PASS	PASS
TRIP INDICATION	PASS(1)	PASS	FAIL(2)	PASS	PASS	PASS	PASS	PASS
VOLTAGE DROP	PASS	PASS	PASS	PASS	PASS	PASS	FAIL	FAIL
ZERO VOLTAGE TURN ON	PASS	PASS	PASS	FAIL(3)	PASS	PASS	PASS	PASS
SAME SLOPE TURN OFF	PASS	PASS	PASS		PASS	PASS	PASS	PASS

SUMMARY OF TEST RESULTS*

* These are tests that were conducted on every unit. In addition Control/Reset Input Voltage and Current, Output Leakage Current and Removal Time to Reset were run on one 10A three phase unit. The unit passed each test.

**** INTERMITTENT RELAY**

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- (1) LEAKAGE IN OFF STATE = 140 µA
- (2) SINKS 10 MA BUT WILL NOT WITHSTAND 30 VOLTS
- (3) EXCEEDED REQUIREMENT BY 2 VOLTS

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3.3.1.1.2 Test Results

The maximum turn-on time for any controller was recorded as 7.5 milliseconds. The following maximum turn-off times were observed:

 10A
 1Ø
 :
 7 milliseconds

 10A
 3Ø
 and 50A
 3Ø
 :
 15 milliseconds

 400A
 3Ø
 :
 25 milliseconds

3.3.1.2 Trip Out Time

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3.3.1.2.1 Test Requirements and Results

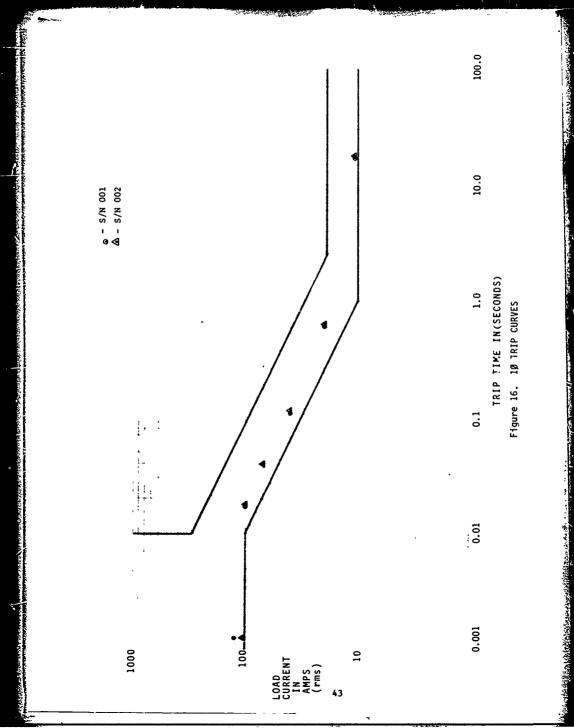
Trip times for each configuration are required to stay within the boundaries of "trip curves" graphed on a log-log scale, based on families of I^2t lines. The trip time data for each controller was overlayed on the graphs (see Figures 16-22) to verify compliance with requirements. All the controllers met the requirements with the exception of S/N 001 of the 50 ampere configuration. The one controller would require a small modification to the ADC reference to correct the deficiency.

3.3.1.3 Overload Trip Indication

3.3.1.3.1 Test Requirements and Results

For all configurations, the state indication, when tripped, was required to sink 10 milliamperes (maximum) with a voltage drop of 1.5 volts dc (maximum). When in the "not tripped" state, the indication was required to have a maximum leakage of 50 microamperes while applying 30 volts dc.

No difficulty was encountered for the tripped state requirements, but one of the units would not withstand the 30 Vdc requirement, due to the wrong transient protector being placed in parallel with the indication. A 12 volt part was inserted instead of a 36 volt part. In addition, one of the units exceeded the allowed leakage by 90 microamperes. Both failures could be corrected without difficulty.



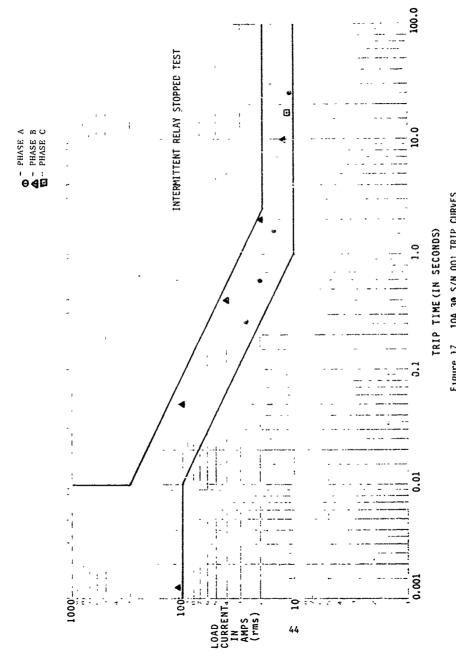


Figure 17. 10A 30 S/N 001 TRIP CURVES

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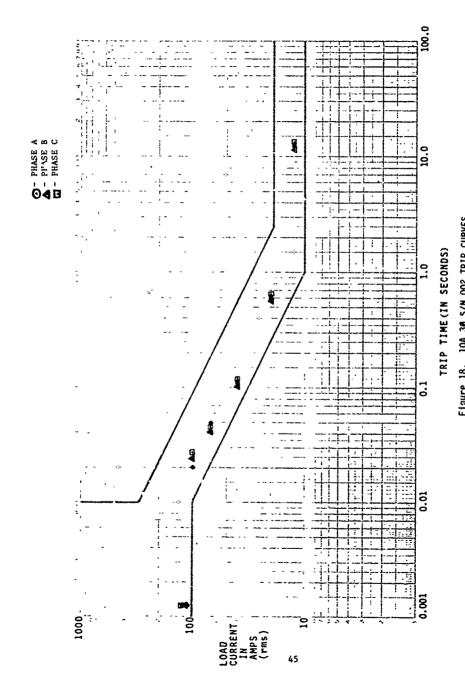
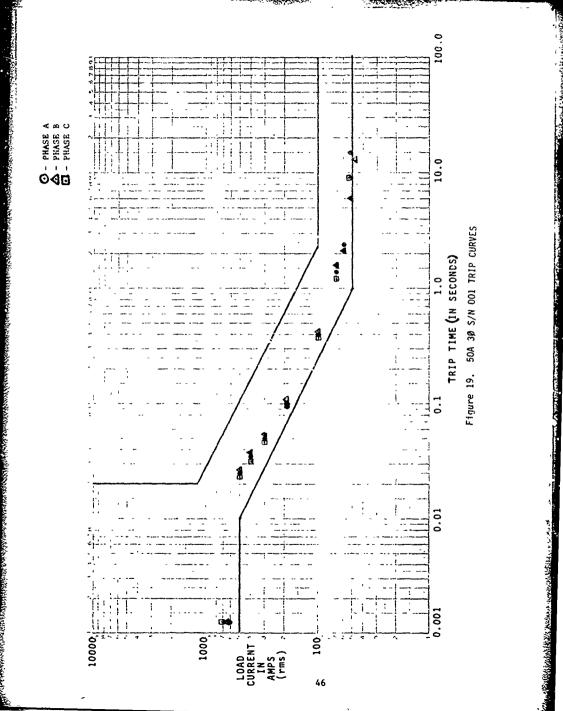


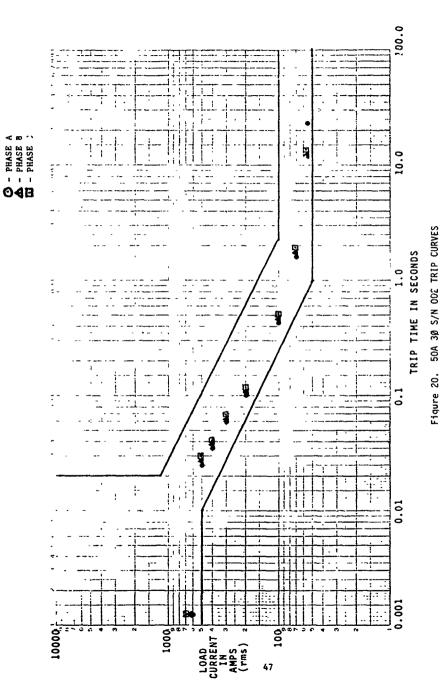
Figure 18. 10A 3Ø S/N 002 TRIP CURVES

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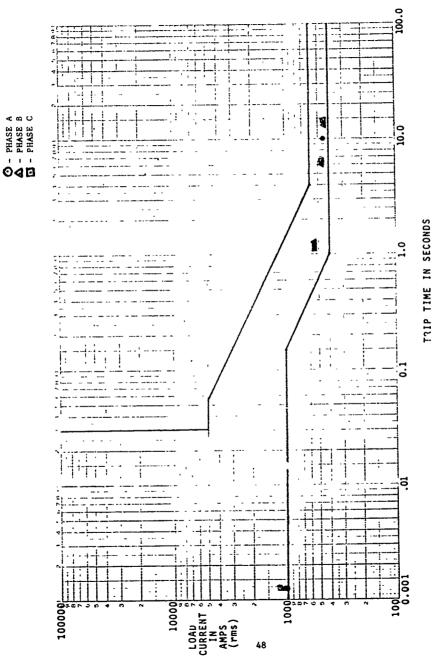
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400A 30 S/N 002 TRIP CURVES Figure 21.

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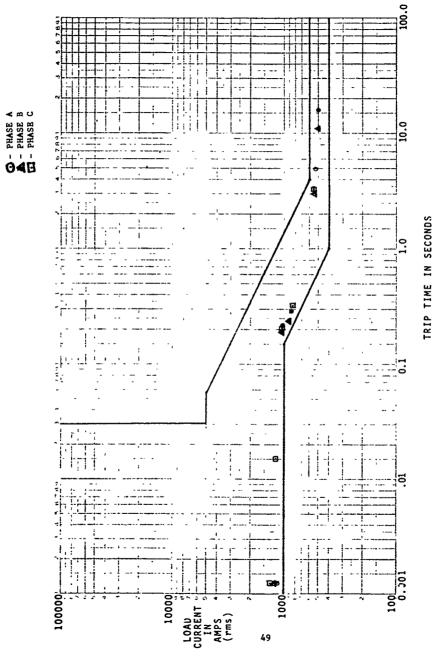
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400A 30 S/N 003 TRIP CURVES

Figure 22.

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3.3.1.4 Output Voltage Drop

3.3.1.4.1 Test Requirements

For all configurations, the HCPCs were required not to exceed 0.300 VRMS drop across the power-in to power-out terminals when carrying rated load. No difficulty was encountered, with the excercion of the 400 ampere units. Test analysis showed the problem to be with terminal-to-cable interfaces and not with the relay or sense resistors.

				Table 10	ł		
	Vo	ltage	Drop	(in volts)	at 100 Per	cent Rated L	oa
				Ø A	ØВ	øc	
10A	1ø	S/N S/N	001 002	0.259			ſ
10A	3Ø	S/N S/N	001 002	0.245	0.250 0.217	0.253 0.220	
50A	3Ø		001 002	0.280	0.230	0.228 0.239	
400A	3Ø		002 003	0.360 0.360	0.390 0.372	0.388 0.390	

The 400 ampere voltage drop could be reduced an average of 100 millivolts by soldering the terminal-to-cable connections in the main current conduction path. ALL STREAM AND A PROPERTY AND

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3.3.1.5 Zero Voltage Turn On/Same Slope Turn Off

3.3.1.5.1 Test Requirements/Results

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All configurations were required to complete turn-on (apply load voltage) at zero voltage crossover \pm 10 volts. In addition, each controller was required to turn-on and turn-off at the same voltage slope. All units except S/N 002 of 10A, three phase configuration, passed without difficulty. S/N 002 turn-on occurred at \pm 12 volts but met the same slope requirements.

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3.3.1.6 Power Dissipation

3.3.1.6.1 Requirements and Results

Controllers were required to meet no load maximums as well as rated load maximums. Results are plotted with requirements in Figures 23-30, and are based on the analysis of power supply dissipation plus the voltage-droptimes-current dissipation experienced in each controller. With the exception of the 400 ampere three phase controller, all configurations met their requirements. The 400 ampere difficulty is caused by excess voltage drop, whose cause has been defined and isolated. See the voltage drop section, paragraph 3.3.1.

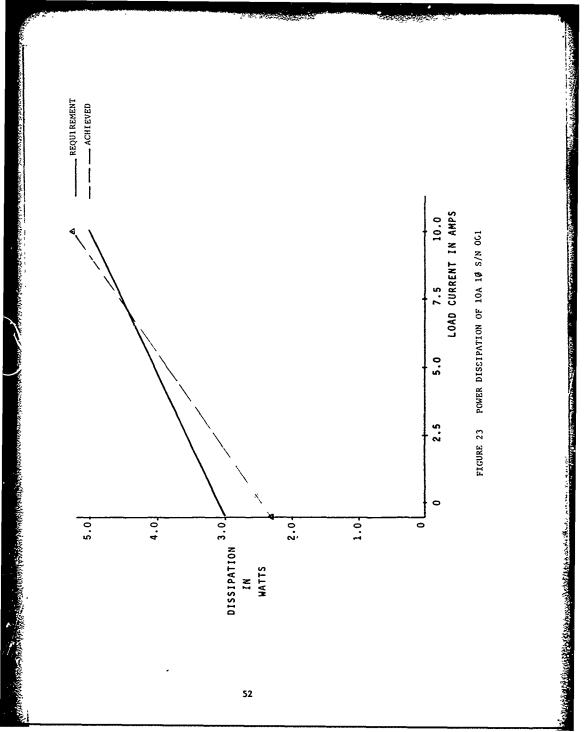
3.3.2 Test Conclusions

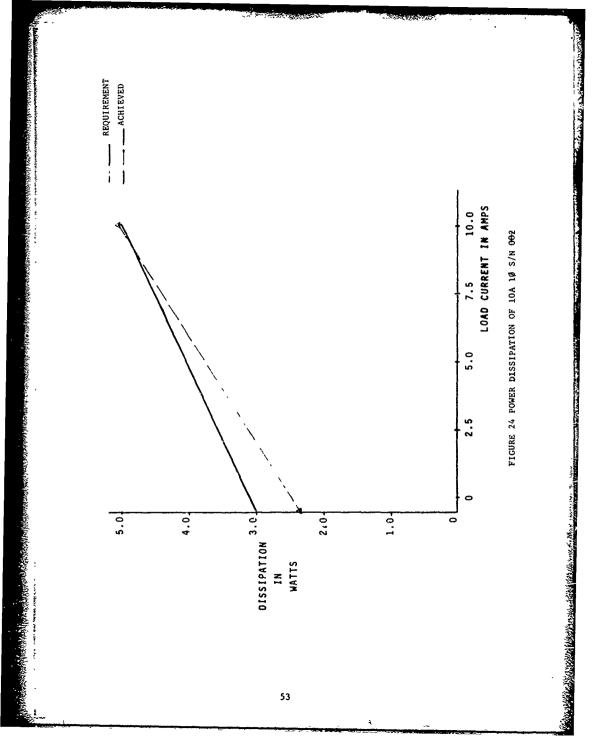
Test results verified that operation of the High Current Power Controllers was in accordance with the greater part of design goals. Each type controller performed satisfactorily in each area of testing with the exception of voltage drop in the 400 ampere units. All problems were identified as correctable with a minimum of further effort.

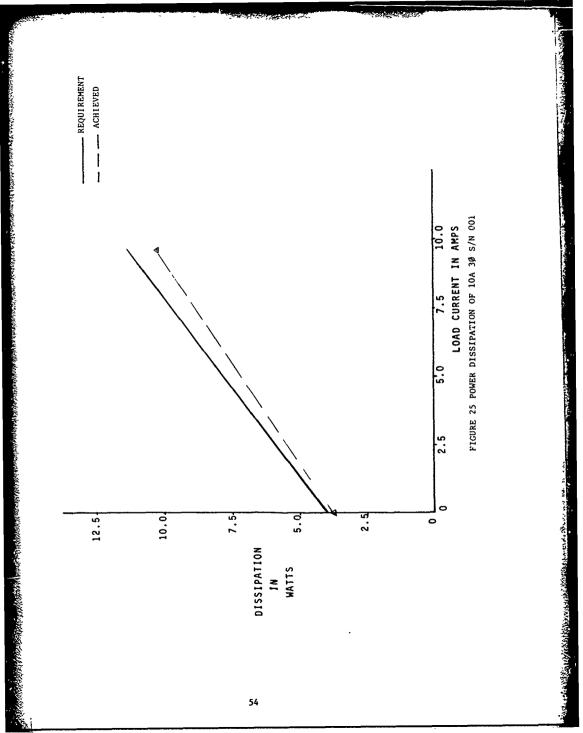
3.4 Reliability/Maintainability

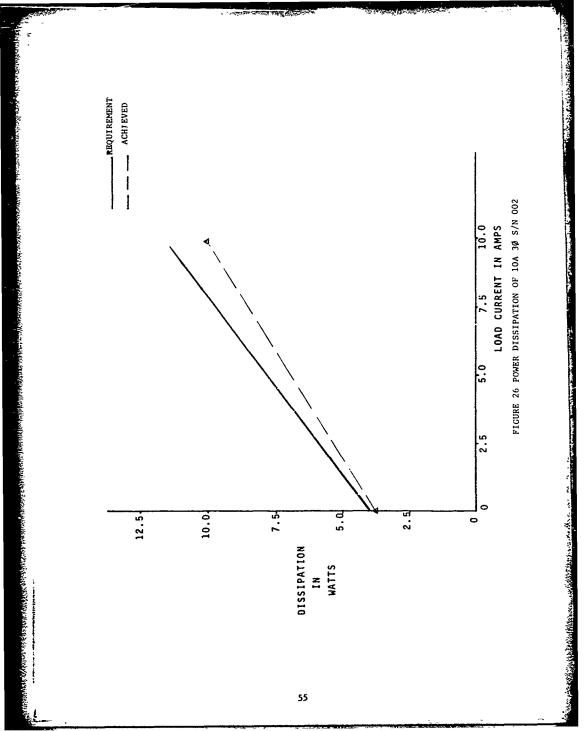
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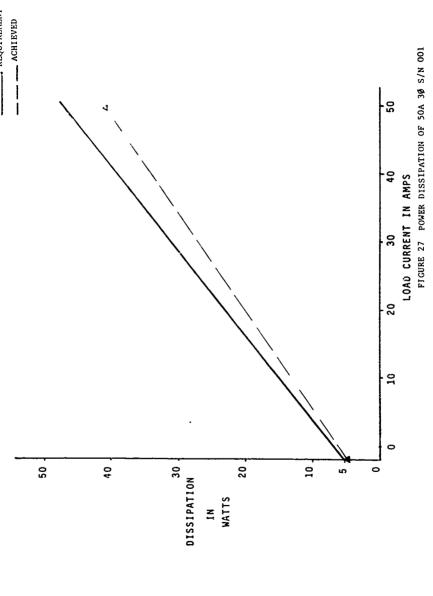
The design inherent reliability of each of the High Current Power Controllers (HCPCs) has been predicted in accordance with the provisions of the reliability prediction handbook. The results of these predictions have been used to project the maintainability characteristics of the HCPC units. The maintainability and reliability potentials of the HCPSs were then compared to the operational reliability and maintainability characteristics of a conventional electromechanical power controller. As shown in the following paragraphs and tables the new design will provide improvements in both the reliability and the maintainability of the power controllers. Appendix B contains the predicated reliability calculations.









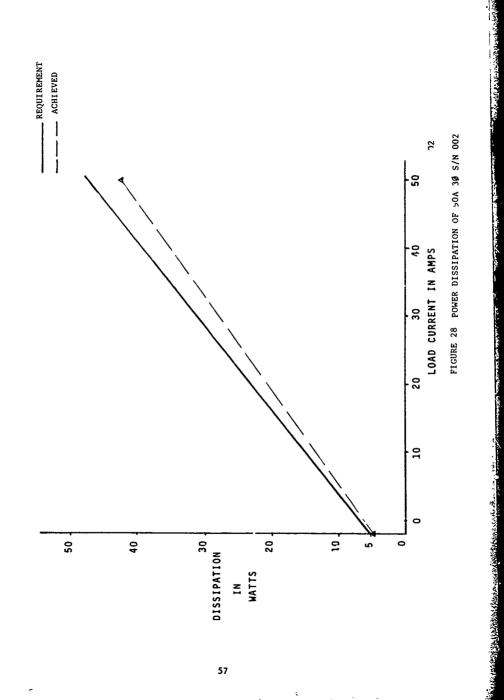


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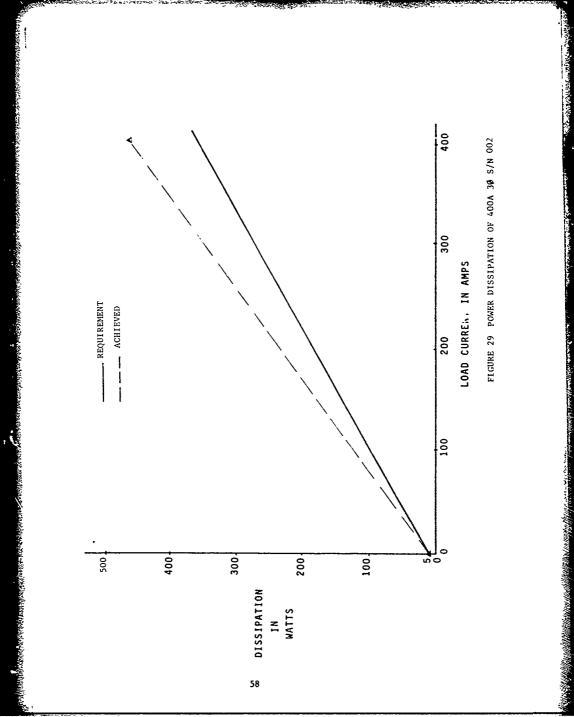
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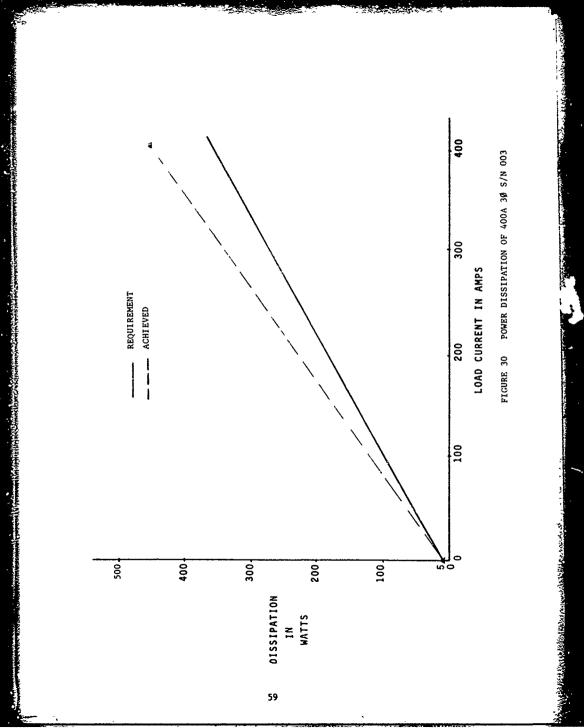
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3.4.2 Reliability

The predicted Mean-Time-Between Failures (MTBF) for each of the four HCPC configurations are summarized in Table 11. Those values are the results of the predictions which were prepared per the provisions of MIL-HDBK-217C Notice 1, "Reliability Prediction of Electronic Equipment". The part failure rate models used for these predictions were taken from this reliability handbook. These part failure rate models unclude the effects of part electrical stress, thermal stress, operating environment, quality level and complexity through the appropriate factors. Since none of the HCPC contain redundancy in their design, the part failure rates were combined using the model for a series system (summation of individual part failure rates).

These predictions reflect the design inherent reliability of meture units which are comprised of high quality parts. For the predictions the following part quality levels were assummed: (1) all transistors and diodes are JANTX, (2) all capacitors and resistors are level R, (3) all integrated circuits are class B, and (4) all other parts are of an equivalent high quality level.

In lieu of more precise data, average part stress values have been used for both the electrical and thermal stress conditions. The average ambient operating temperature was estimated to be 50°C. The electrical stress ratios were estimated to be 0.6 for all parts used in normally active circuits and 0.1 for parts used in circuits which are normally off or in a standby mode.

3.4.3 Maintainability

A maintainability study of the HCPC controller was completed to afford a basic for determining realistic and meaningful maintainability requirements.

The preliminary corrective maintenance time prediction which reflects the new HCPC design, was derived using the procedures described in MIL-HDBK-472. The mean corrective maintenance time (\bar{M}_{c}) was calculated using the following formula: ሳን ቆንድ ሲያሪ የትድረድ ይህ ታይሦስቱ በጉሥ አሳሌ ህን በሃይፍ ጥጥ አባለሉ

TABLE 11

PREDICTED RELIABILITY

Component Type	10 QT/	10 Amp 1 Phase QTY A Failures/10 ⁶ HR	10 17 17	10 Amp 3 Phase QTY A Failures/10 ⁶ HR	so QTY	50 Amp 3 Phase QTY A Failures/10 ⁶ HR	400 QTY	400 Amp 3 Phase QTY A Failures/10 ⁶ HR
Capacitor	38	0.61640	58	0.93098	58	0,93098	58	0.93098
Resistor	38	0.10331	52	0.12338	56	56 0.19133	71	0.28985
Diode	22	1.80288	25	1.90368	26	1,96416	26	1.98432
Transistor	12	2.23402	22	3.28926	22	3,28926	24	3.42966
SCR	5	0.80000	ŝ	2.40000	6	4.20000	14	6.24000
JC	12	0.75878	12	12 0.75878	12	12 0.75878	12	0.75878
Relay		0.00703	-	0.02814	~	0.05628		0.05979
Sensor		1 1.08476	ŝ	3.25428	ю	3.25428	ю	3,25428
Misccllaneous	11	1.09358	21	21 1.46322	22	22 1.56322	24	1.85858
TOTAL	137	8.50076	200	200 14.15167	210	210 16.20829	234	18.80624
NTBF		117,637 IIR	_	70,663 HR	•	61,697 IIR		53,174
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$$\overline{M}_{c} = \frac{\Sigma(\lambda M_{c})}{\lambda}$$
(1)

Where:

 λ = average part failure rates in failures per 10⁻⁶ hours

M_c = corrective maintenance time in hours

The predicted corrective maintenance times for each of the HCPC's, LRU's and SRUs, have been summarized in the following table.

TABLE 12

Predicted Mean Corrective Maintenance Time Summary

LRU	<u> </u>
10 AMP 1 PHASE	52 Min
10 AMP 3 PHASE	52 Min
50 AMP 3 PHASE	53 Min
400 AMP 3 FHASE	54 Min
SRU	M
POWER SUPPLY	56 Min
MICRO PROCESSOR	58 Min
SCR ELECTRONICS	56 Min

3.4.4 Qualitative Comparison

A qualitative comparison was made between the HCPC and a conventional electro-mechanical power controller. The conventional design uses a circuit breaker, a relay and a relay driver. This conventional design, though less complex (fewer parts) will be less reliable and will require more maintenance then the new HCPC. The improvement in reliability has been achieved primarily by eliminating the circuit breaker and reducing the electrical stress on the relay. Both of these actions eliminate or minimize possible mechanical wearout modes.

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The prototype design incorporates several unique maintainability design features. They include the use of "standard modules", used throughout the different LRU configurations. All configurations use the same Power Supply, Microprocessor and SCR module. Also all equipment required is packaged in one LRU configurations. They require no adjustment at the LRU level. The Power Controllers require no schedule maintenance or on aircraft adjustments.

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Table 13 summarizes pertinent characteristics of the HCPC and electromechanical units for comparison.

TABLE 13 Qualitative Characteristics Comparison

	Compartson Comments		New design allows for remotely located Power Controller	a) Improved reliabilityb) Improved maintalnabilityc) Improved availability	d) Lower cost due to repair	Improves: a) Reliability b) Maintainability c) Cost of repair d) Availability
mparison	New Design	Electronic	Inhabited or uninhabited	AND		Same Same Same Same No load switching No arcing
VUALITACING UNALOCCEPISTICS COMPARISON	Current Design	Mechantcəi	Inhabited only	 a) Contact Bounce b) Arcing when switched under load. c) Particle Contamination due to contact action 	d) Limited life due to wearout	Same Same Same Same Switched under load-arc damage to contacts,
	Function/Item Circuit Breaker Function	 Configuration 	2) Design Environment	3) Fallurc Nodes (Electro-Morhan(cal)		<u>kelay/Relay Driver</u> 1) Design Environment 2) Part Quality Level 3) Package/Mounting 4) Material Cost 5) Failure Modes

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TABLE 13

Qualitative Characteristics Comparison (contd)

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Comparison Comments	 Plug-In Modules Interchangeable between plug-in slots Standard modules for multiple configuration application. 	 Fewer part types to control Reduces overall mfg. cost Material Material Fab Test Reduces overall repair cost Customer COO Some advantages to packaging design 	 Fewer interface connections with user hardware Decreases weight, cost, value Requires less overall setup and test time Improves maintenance and repair time Improves maintenance and test time Lends itself to higher reliability applications Fewer items to spare-trade-off be- tween cost of sparing for 3 vs 1 them even though the unit cost of 1 item may excerd that of the 3 items. 			
New Design	3 Modules	Modules	1-LRU	None	None	Much Improved
Current Design	DNA	VNQ	3-LRUS	Unknown	None	Basel ine
<u>Function/Item</u> General Design	hodule Design	Standard Modules	Packaging	Adjustments	Scheduled Ma ¹ ntenance	Non Scheduled Maintenance

3.4.5 Quantitative Comparison

For further comparison purposes the operational reliability of the conventional electromechanical controller has been established by assuming that the units will meet the reliability requirements of the B-1 specifications. Table 14 lists the predicted reliabilities and corrective maintenance times of the various units.

TABLE 14

Predicted Reliability & Maintainability

NEW	нсрс	DESIGN	
-----	------	--------	--

		10 Amp 1 Phase	10 Amp 3 Phase	50 Amp 3 Phase	400 Amp 3 Phase
MTBF	NEW DESIGN	117.637 Hr.	70, 663 Hr.	61,697 Hr.	63,174 Hr.
	EXISTING DESIGN	30,110 Hr.	38,110 Hr.	38,110 Hr.	38,110 Hr.

3.5 Safety

and interesting a strategy and the construction of the prove of the construction of the state of the state of the

A hazard analysis was conducted on the High Current Power Controllers, as high voltages/currents are handled as a matter of course. Terminal layout, relative to voltage isolation between phases and leakage current wore of primary concern. All precautions in the design were taken to minimize hazard to personnel.

During normal operation, HCPus pose no hazard, but under certain operating conditions potential hazards do exist. They are:

- During any activity where power is applied to the HCPC and touching, probing or otherwise making contact with the controller is planned
- (?) With power applied to the controller and no loid attached to the powerout terminal, or with system wiring attached but no load connected, a potential shock bazard exists should an ou_-of-specification HCPC be employed. Care should be exercised not to make contact with either the power out terminal or the unloaded end of the system wiring. The bazard analysis results are shown in Table 15.

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TABLE 15

HAZARD ANALYSIS

AREA CONSIDERED

Isolation of Energy Sources 3

COMMENTS

from all non-insulated elements within can Metal can electrically isolated by a minimum of 30 mils of potting. The potting has a volume resistivity larger Interface terminal separation 0.5 inch than 10¹⁴ ohm-cm. minumum. Э

None

System Environmental Constraints

Fuels and Propellants

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to 75°, acceleration is 20g, mechan-None except those specified in the procurement specification, i.e., the case (can) temperature (operating) shall be ical shock is 50g for 11 milliseconds. -40%

the second

None

- Compatible materials used. Э
- Potting of assemblies protects against corrosion. 3
- Electromagnetic radiation from unit prevented by metal case and metal screen. Э
- Effect of nuclear radiation on unit not a requirement. 3

None

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Unit will not cause a problem.

- Possible excess leakage current diverted to power neutral. Э
- Interface terminals can be insulated after connections are made. 3
- Unit can be disassembled to a moderate degree Metal case can be connected to system ground. ΞŦ
 - for maintenance.

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Compatibility of Materials

Explosive Device

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- Effects of Radiation £
- **Pressure Devices** 3
- **Crash Safety** E
- Safe Operation and Maintenance of System Э

TABLE 15

HAZARD ANALYSIS (continued)

AREA CONSIDERED

(j) Training

- (k) Egress, rescue, etc.
- (1) Life Support Requirements
- (m) Fire Ignition and Propagation
- (n) Resistance to Shock Damage
- (o) Environmental Factors
- (p) Fall Safe Design Considerations
- (q) Safety from a Vulnerubility and Survivability Standpoint
- (r) Protective Clothing, Equipment or Devices
 - (s) Lightning and Electrostatic Protection
- (t) Human Error Analysis

COMMENTS

Deferred to production phase.

Not applicable.

Not applicable.

Unit will not ignite or propagate a fire; potting eliminates source of oxygen.

Excellent - unit potted.

Not applicable.

10 ampere units contain a fail safe fuse, fuse not required on 50 and 400 ampere units.

Excellent; unit is compact, potted in a metal case-contains no exposed elements that will readily break.

None required.

Metal case can be grounded to vehicle structure.

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Not applicable.

3.6 Design to Cost

Consideration was given to a specific design-to-cost effort in each phase of the HCPC program. All decisions relative to HCPC design, especially in the packaging area, contained basic design-to-cost criteria.

The key elements providing the lowest possible costs consistent with reliable power controllers are:

- Standardized electronics, including the microcomputer concept that allowed sufficient flexibility for use in four configurations
- (2) Standard module size for maintainability/repairability
- (3) Maximum use of two sided PCB's to mount and interconnect the electronic parts
- (4) Minimum number of sub-assembly types, including PCBs
- (5) The decision to pot all the hardware in the enclosures was partly based on anticipated lower costs; this eliminated the need for most of the loose hardware and the assembly steps that would have been required to fasten the sub-assemblies in various areas of the enclosures.
- (6) The costs associated with fabricating the interconnections and assembling the SCRs into back-to-back switches for the 50A and 400A configurations (the method originally proposed) were eliminated by replacing this design approach with purchased pre-assembled SCR pairs
- (7) The enclosures are "drawn" off-the-shelf cans or modifications of the same, replacing the more expensive cast or brazed housings selected for the preliminary designs

Decisions relative to short versus long term production and production volumes are critical in a development program. Tooling costs, mask charges, assembly techniques, etc. can be absorbed with a minimum impact on a larger production program. Should a production follow-on be initiated, further studies would need to be conducted concerning elements such as hybrid versus discrete mechanization and wire harness versus mother board/connector approaches.

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SECTION IV

CONCLUSIONS AND RECOMMENDATIONS

The HCPC development program has added a new, desirable candidate configuration to the area of high voltage, high current power controllers. HCPCs provide all the electronic benefits of solid state power control without the disadvantages of high power dissipation/voltage drop and DC offset voltage associated with solid stat: switch elements. HCPC advantages over the electromechanical configurations include reduced EMI, full cycle control, i.e. load voltage slope control during turn-on and turn-off, and increased reliability. The program also:

- Provided operating prototypes of flightworthy versions of the 10 ampere, one phase and 10 ampere, three phase controllers and brassboard models of the 50 ampere, three phase and 400 ampere three phase controllers
- (2) Provided a method for the virtual elimination of potential shock hazard, during a no load condition, to maintanence personnel
- (3) Verified the concept of microcomputer flexibility for power controllers

The HCPC development effort also indicated the desirability, from a cost and functional operation viewpoint of further modifying the augmented circuit configurations. The system design changes recommended are:

- (1) Replace the relatively expensive magnetic current sensor (1 per phase) with CMOS microcomputers (1 per phase); the costs of 3 CMOS µCs and 3 ADCs is expected to be significantly lower than the cost of the 3 magnetic current sensors replaced.
- (2) Recent breadboard test indicated that SCR gate drive current could be obtained through field effort transistor switches from the power bus. Such a change would significantly reduce the current required from the HCPC power supply.
- (3) The use of the inherently low power CMOS µCs (they were not available during Phase I and II of the HCPC program) plus deriving SCR gate power directly from the power bus, would allow a significant reduction in the size and complexity of the HCPC power supply module.

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Recommendations concerning detailed design changes include:

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- (1) Problems were encountered with reducing the noise couplei to the input of the ZVC circuit. It is recommended that future HCPC configurations move this circuit from the Power Supply module to the Microcomputer module.
- (2) The power transformer should be redesigned to include an electrostatic shield be ween the primary and secondary windings. This change would not be necessary if the HCPCs convert to the simplified power supplies previously mentioned.
- (3) Several moderate problems are foreseen with repairing the hard potted units (the production packaging) indicating that the approach should be modified to replace the epoxy potting used as the housing lid with an inherently hard material such as epoxy glass board. This would allow a reusable lid, a reduction in weight, and enhance the ease of repairability of the controliers.

APPENDIX A

HIGH CURRENT POWER CONTROLLER (HCPC) RESEARCH & DEVELOPMENT TEST PLAN CONTRACT F33615-78-C2202

1. <u>SCOPE</u>

1.1 Introduction

This document defines the Compliance Test requirements for High Current Power Controllers (HCPC's).

This document is prepared to satisfy the requirements of Contract Data Requirement List (CDRL) Sequence 008, "Research and Development Test Plan".

1.2 HCPC Description

The HCPC is primarily planned for use to control 115 volt, 400 Hz AC power within an aircraft. Four types of HCPC's are herein to be tested; (1) a 10 ampere, 1 phase, (2) a 10 ampere, 3 phase, (3) a 50 ampere, 3 phase, and (4) a 400 ampere, 3 phase controller.

1.3 Administrative Data

1.3.1 Furpose of Test

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The tests listed in this document shall be performed to satisfy the requirements for a functional test of the deliverable HCPC's specified by the AFAPL F33615-78-C-2202 Procurement Specification.

1.3.2 Manufacturer Test Item Description

10A 1 ♀ Fiightworthy HCPC : 14255-507-1 10A 3◦ Flightworthy HCPC ≥ 14256-507-1 50A 3◦ Flightworthy HCPC ≥ 14257-507-1 400A 3◦ Flightworthy HCPC ≥ 14258-507-1 50A 3◦ Breadboard HCPC ≥ 14259-507-1 400A 3◦ Breadboard HCPC ≥ 14269-507-1

1.3.3 Items To Be Tested

All items delivered shall be tested as indicated in this specification.

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1.3.4 Security Classification

Unclassified

1.3.5 Test Location

Rockwell International, ASSD, Anaheim, California, Buildings 231, 251, and 252.

1.3.6 Disposition of Test Specimen

To be delivered to AFAPL as specified in Section J, Paragraph Xi of contract.

2.0 APPLICABLE DOCUMENTS, MATERIAL AND EQUIPMENT

2.1 Documents Required By This Specification

The following documents, to the extent indicated, form a part of this specification. In the event of any conflict between the requirements of this specification and the listed documents, the requirements of this specification shall govern.

2.1.1 Specifications

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Drawings, Specification or Exhibit

Autonetics:	C79-463.1/201 Test Plan	нсрс	Research	and	Development	
					boro opinicito	

AFAPL F33615-78-C-2202 HCPC Development Specification

2.2 Documents Calling Out This Specification

In the event of any conflict between the requirements of this specification and documents calling out this specification, the requirements of the document calling out this specification shall take precedence.

2.3 Equipment and Material

- 2.3.1 Equipment and material used shall be selected to achieve the purpose of this process specification.
- 2.3.2 External components specified in this document may be replaced by components with equivalent electrical characteristics.
- 2.3.3 Test equipment such as switches, meters, loads and power supplies shown in Figure 1 are used to indicate the stimuli and responses required to conduct a particular functional test. Other test equipment and/or test sequences that provides the same stimuli and responses and that performs an equivalent functional test may be used.
- 3 REQUIREMENTS

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- 3.1 General Requirements
- 3.1.1 Safety Precautions
- 3.1.1.1 Electric potentials in excess of 200 volts and currents exceeding 400 amperes may exist in the HCPC or on the test equipment ronnected to the HCPC. Extreme caution should be observed in touching, probing or otherwise making contact within the HCPC or the test equipment.
- 3.1.1.2 The HCPC shall not be connected to or removed from energized equipment.

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- 3.1.2 Environmental Conditions
- 3.1.2.1 Operations required by this process shall be performed at ambient temperature of 25 (+15, -5)°C, a barometric pressure of 30 + 2 inches of mercury, and a relative humidity up to 90 percent.

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3.1.2.2	Cooling air, at ε temperature of 25, +15, -5 C and a relative	<i>ي</i> ۽
	humidity of less than 90% shall be supplied to the HCPC at a flow rate equal to or greater than 50 CFM.	
	The face equal to of disater than 50 this.	8-74 74
3.1.3	Record of Data	
		調査の
3.1.3.1	Test data required by this specification may be recorded on	
	any suitable form.	
		Į.
3.1.3.2	Paragraphs preceded by (R) require recording data.	Î
3.1.4	Preliminary Examination	L. L
	• • • • • • • • • • • • • • • • • • •	P
3.1.4.1	Before testing, the unit shall be checked to see that it has passed assembly inspection.	
	Free	
3.1.5	Measurements	
3.1.5.1	When determining the acceptability of a test value, the specifi-	ļ
	cation limits shall be considered absolute, regardless of the number of decimal places, and are to be used as if they were	
	continued with zeros.	ļ
		Ļ
3.1.5.2	Absolute values are specified herein. The calibrated tolerances	
	of the measuring equipment must be subtracted from the absolute limits.	
3.1.5.3	Unless otherwise specified, meter tolerances shall, at no time,	1
	be greater than 5 percent of the voltage and current specified. This does not apply to waveform measurements.	
	The same which as the same meaning succession.	
3.1.6	Test Personnel	500 A
		An a so a station of a
3.1.6.1	Personnel performing the requirements of this specification shall	****
	have a working knowledge of the type of equipment used to test the HCPC.	ži ži
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3.1.7 Equipment Calibration

3.1.7.1 Personnel performing the requirements of this specification must confirm that the test equipment used to test the HCPC is calibrated and sealed.

3.1.8 HCPC Power, Signal, and Load Requirements

To demonstrate the electrical performance of the HCPC, the following power levels and loads shall be used.

3.1.8.1 Power Requirements

Symbol	(Volts)	<u>(Hz)</u>	Maximum Current Requirement
o* ac in	(80 - 150) VRMS +	3¢ 400 <u>+</u> 22	4000 A
CONTROL	0.0 - 8.0**	DC	10 mA
TRIP	30.0, + 0 - 0.3	DC	10 mA(current limited)

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+ Voltage is nominally 115 RMS, but is variable throughout range specified.

* Terms are A through C.

**Voltage is variable throughout range specified.

3.1.8.2 Signal Requirements

3.1.8.2.1 Trip Indication

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3.1.8.2.1.1 The HCPC Trip Output signal shall be at non-tripped condition during normal operation and at the tripped condition following on electrical overload as follows:

Term	State	<u>Vt</u>	<u>It</u>
TRIP	Non-Tripped	30, +0 - 0.3 Vdc	<0.05 mA
TRIP	Tripped	≤ 1.5 Vdc	10 <u>+</u> 0.1 mA

3.1.8.2.2 Control Input Signal

3.1.8.2.2.1 The HCPC AC output is commanded by the Control Input signal. The Control Input Signal is True to command the AC Switch "ON" and False to command the AC Switch "OFF".

Term	State	<u>V1</u>	I_2
CONTROL	True (ON)	5 + 3.0, -1.5 Vdc	\leq 10 mA
CONTROL	False (OFF)	0.0 + 2.0, -0.0 Vds	< 1.0 mA

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- 3.1.3.2.3 All alternating voltages and currents are R.M.S. unless otherwise specified.
- 3.1.9 Test Sequence

Unless otherwise specified, the test requirements of this specification may be performed in any sequence.

3.2 Detail Requirements

Testing of the HCPC will include but not be limited to the test outlined in Table I.

3.2.1 HCPC_Tests

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3.2.1.1 Control Input Voltage & Current

TABLE I.

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Compliance Test For High Current Power Controller

					I tems To	tems To Be Tested	
		MIL-P-81653B Paragraph	: Paragraph	104	10A	50A	400A
	Examination or Test	Req.	Method	19	90	36	and m
i.	Control/Reset Input Voltage and Current	3.11.1	4.8.7.1	111	LIA	IIA	LIA
<u>ہ</u> .	Control Input Transients	3.11.22	4.8.7.22	ı	1	ı	•
э.	Overload Trip Indication	3.11.14	4.8.7.14	AII	All	111	IIA
4.	Turn-On & Turn-Off Times	3.11.2	4.8.7.2	AII	AII	llA	IIA
5.	Isolation	3.11.4	4.8.7.4	1	1	•	ı
ę.	Output Voltage Drop	3.11.6	4.8.7.6	IIA	LIN	LIA	IIA
7.	Output Leakage Current	3.11.7	4.2.1.7	All	11	A11	III
8.	Operating Voltage Transients	3.11.19	4.8.7.19	ı	IJ	i	•
9.	Zero Voltage Turn-On, Zero Current Turn-Off	3.11.23	4.8.7.23	ILA	LIA	LIA	11A
10.	Trip Out Time	3.11.9.2	4.8.7.9.2	IIA	All	A11	llA
11.	Power Dissipation	3.11.8	4.8.7.8	-		1	-
12.	Radio Interference (Conducted)	3.15	4.8.18	ı		I	·
13.	Removal Time To Reset	3.11.13.2	4.8.7.13	ı	1	•	•
14.	Trip Free Characteristics	3.11.17	4.8.7.1/	ı	1	•	•
15.	Fail-Safe	3.12		1	1	•	•
16.	Rupture Capacity	3.11.11	4.8.7.11	1	1	1	1
17.	Temperature/Altitude	3.13	4.8.14	1	-	·	
18.	Shock	3.13	4.8.19	IJ	-1	•	
13.	Vibration	3,13	4.8.11	1	1	·	

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3.2.1.1.? <u>Requirement</u>. When tested as specified, the turn-on and turn-off voltage shall be as follows:

Control Circuit (All Configurations)

Supply Voltage	+8.0 Vdc maximum +5.0 Vdc rated
Turn-on Voltage	+3.5 Vdc minimum
Rate of Change	0.5 volts/microsecond/minimum
Turn-off Voltage	+2.0 Vdc maximum
Rate of Change	0.5 volts/microsecond/minimum
Input Current	10 milliamperes maximum +5.0 volts rate input voltage

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3.2.1.1.2 <u>Test Method</u>. The turn-on and turn-off voltages shall be verified as follows:

Turn-on Voltage. With the controller connected as shown in Figure 1, apply rated supply voltage and adjust the load resistance for rated load \pm 10 percent. Apply the minimum turn-on voltage with the control function generator and note that the controller turns ON. Record results as Pass/Fail.

Turn-off Voltage. With the controller ON at rated control, apply the maximum turn-off voltage with the function generator and note that the controller turns OFF. Record results as Pass/Fail.

- 3.2.1.2 Control Input Transients
- 3.2.1.2.1 <u>Requirements</u>. When tested as specified, the controller shall not be damaged.
- 3.2.1.2.2(R) <u>Test Method</u> The following transients shall be applied between the signal ground terminal and the control terminal (source impedance is 500 ohms):

A train of ten pulses of plus and minus 100 volt peak amplitude and 100 microsecond duration each, repeated 10 times at 3 second intervals.

Repeat test (1) between terminals, trip indication and ground. Record results as Pass/Fail.

3.2.1.3 Overload State (Trip Indication)

3.2.1.3.1 <u>Requirement</u>. When controllers are tested as specified, the state indication shall be as follows:

State Indication Signal (All Configurations)

Tripped	1.5 volts dc maximum, sink 10 mA maximum
Not Tripped	50 microamperes maximum dc leakage at 30 volts

- 3.2.1.3.2(R)<u>Test Method</u>. Connect the controller as shown in Figure 1 Apply rated supply voltage and adjust the load resistance for 200 ± 10 percent rated load. Acply control signal and observe that the controller turns ON and trips out. With the indication sinking 10 mA, measure and record the voltage drop from "Trip" to ground. it must not exceed 1.5 Vdc. Remove the control signal and observe the controller reset. Keasure and record leakage of indication when applying 30 Vdc ± 1%. It must not exceed 50 microamperes.
- 3.2.1.4 Turn-On & Turn-Off Times

3.2.1.4.1 <u>Requirement</u>. when tested as specifies, the lurn-on and turn-off times shall be as follows

gurations)	
15 miliseconds maximum	
A ;	
20 milliseconds maximum	
30 milliseconds maximum	
	A; 20 milliseconds maximum

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3.2.1.4.2(R) Test Method. Measure and record turn-on and turn-off times with the controller operated as follows.

<u>Turn-On Time</u> With the controller connected as shown in Figure 1, apply rated supply voltage and adjust the load resistance for rated load \pm 10 percent. Apply the minimum turn-on voltage with the control function generator and note that the controller turns ON. Record the time between application of control and receipt of ac power to the load.

<u>Turn-Off Time</u> With the controller ON at rated centrol voltage, apply the maximum turn-off voltage with the function generator and note that the controller turns OFF. Record the time between removal of control and removal of AC power from the load.

3 ? 1.5 Isolation

มระบบ มีขณะสะระรับรายสะทะทางระบบระบบระบบระบบระบบ มาการประทศสะทรที่สารหรือสะระรับราชารีสารที่สารที่สารประวัตร ประ

3.2.1.5.1 <u>Requirements</u>. When tested as specified, the following require ments apply:

<u>Dielectric Withstanding Voltage</u>. There shall be no leakage current in excess of 1.0 milliampere (ma) nor evidence of damage to arcing (air discharge), flashover (surface discharge), or insulation breakdown (purcture discharge).

Insulation Resistance. The insulation resistance shall be greater than 100 megohms.

3.2.1.5.2(R) <u>"est Method</u>. The power-in terminal, power-out terminal and power-ground terminal shall be shorted together. Where applicaple, the control terminal, state indication terminal, and signe ground terminal shall be shorted together. Measurement shall be made in accordance with the following MIL-STD-202 paragraphs, except the points of application shall be between the signal ground and power ground terminals.

insulation Resistance. Controllers shall be tested in accordance with Wethod 302 of MIL-STC-202. The following details shall apply:

- a Test condition A
- 5. Preparations None
- Points of Measurement The terminals shall be shorted together and measurements taken between enclosure and terminals.
- d. Electrification Time 2 minutes
- e. Measurement Error As specified in MIL-STD-202.

3.2.1.5.2(R) Continued

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<u>Dielectric Withstanding Voltage</u>. Controllers shall be tested as follows:

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Contraction (Article Content or Contraction (Article Article)

<u>At Atmospheric Pressure</u>. Controllers shall be tested in accordance with Method 301 of MIL-STD-202. The following details shall apply:

- a. Preparations Not applicable
- b. Test Voltage 1000 vRMS
- c. Nature of Potential AC
- d. Duration As specified in MIL-STD-202
- e. Points of Application All terminals shall be shorted togetner and the test voltage applied from terminals to case.
- f. Leakage Current 1.0 mA maximum
- g. Following these tests, controllers shall be examined for evidence of arcing, flashover, insulation breakdown and damage.

3.2.1.6 Output Voltage Drop

- 3.2.1.6.1 <u>Requirements</u>. When tested as specified, the voltage drop shall not exceed 0.3 vRMS maximum (per phase) for load current values from no load to 100% rated.
- 3.2.1.6.2(R) <u>Test Method</u>. With the controller connected as shown in Figure 1, measure and record the voltage between the power-in and power-out terminals while operating at 10, 50, and 100 percent rated load. A true RMS voltmeter shall be used.
- 3.2.2.7 Output Leakage Current
- 3.2.1.7.1 <u>Requirement</u>. When tested as specified, the leakage current shall not exceed the following values:

10 A and 50 A Configurations	1 πA (Per Phase) at rated voltage
400 A configurations	10 mA (Per Phase) at rated voltage

A-12

3.2.1.7.2(R) Test Method. Connect the controller as shown in Figure 1. With the load resistance adjusted for a maximum of 10K ohms rated supply voltage applied and the control circuit open, measure and record the leakage current. article and an article and the second sec

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3.2.1.8 Operating Voltage Transients

- 3.2.1.8.1 Requirements. When tested as specified with the control signal OFF, the controller shall not be damaged, be tripped or deviate from the OFF state. With the control signal ON, the controller shall not be damaged or tripped, but may go to the OFF state.
- 3.2.1.8.2(R) Test Method. Connect the controller as shown in Figure 1. Adjust load resistor for rated load and control function generator for maximum turn-off voltage. Apply control signal and perform the following tests, verifying the requirements in 3.2.2.8.1 with Pass/Fail.
 - Apply rated supply voltage and frequency for 5 seconds and then apply 180 volts rms for a period of 0.120 seconds.
 - b. Apply rated supply voltage and frequency for 5 seconds and then apply 140 volts rms for a period of 1.3 seconds.
 - c. Apply rated supply voltage and frequency for 5 seconds and ther apply 65 volts rms for 0.020 seconds.

3.2.1.9 Zero Voltage Turn-On/Zero Current Turn-Off

- 3.2.1.9.1 Requirement. When tested as specified, controller turn-on shall occur at zero voltage crossover ± 10V, and the controller turn-off shall occur at zero current crossover ± 0.5A, ± 2A and ±20A for the 10A, 50A and 400A configurations. Tespectively. The controller shall turn-on and turn-off at the same voltage slope (turn-off at the opposite half-cycle from turn-on).
- 3.2.1.9.2(R) <u>Test Method</u>. Connect the controller as shown in Figure 1. Apply rated supply voltage and adjust load resistor for rated load. With the control function generator adjusted for rated turn-on voltage, first apply and then remove the control signal and monitor the load voltage and current. Measure and record the turn-on and turn-off points.

3.2.1.10 Trip-Out Time

3.2.1.10.1 Requirements

- a. <u>Non-repetitive Reset</u>. When tested as specified, the trip time shall be within the limits specified in Figure 2 A, B, C and D (minimum 2.0 seconds between resets).
- b. <u>Repetitive Reset</u>. When tested as specified, the controller trup times shall be within the limits specified in Figure 2. The controller shall not be damaged.
- 3.2.1.10.2 Test Method. Connect the power controller as shown in Figure 1.
 - a. <u>Non-repetitive Reset</u>. With rated supply voltage, verify that the controller meets the specified trip characteristics at overcurrent levels of 200%, 700% and 1250% of maximum rated current.
 - b. <u>Repetitive Reset</u>. With rated supply voltage and load resistor adjusted for 200 ± 10% rated load, apply control signal 10 times at 5 second intervals, observing the controller trip each time the control is applied. Record the results on a Pass/Fail basis.

3.2.1.11 Power Dissipation

3.2.1.11.1 <u>Requirements</u>. When tested as specified, the power dissipation shall not exceed the values specified in Figure 3 A, B, C and D for 'ON' and the following for OFF.

OFF	10 A,	10	=	3.0 watts
OFF	10 A,	3 ¢	=	4.C watts
0FF	50 A,	3φ	=	5.0 watts
OFF	400 A.	3 Ø	=	5.0 watts

3.2.1.11.2(R)<u>Test Method</u>. Connect the controller as shown in Figure 1 with the load resistance adjusted for short circuit. With rated supply voltage appled, and the controller OFF, measure and record the power dissipation for the OFF state. Measure and record the power dissipation for the ON state for loads of 10, 50, and 100 percent rated load with the rated control voltage applied.

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3.2.1.12 Radio Interference (Conducted)

- 3.2.1.12.1 <u>Requirement</u>. When tested as specified, controllers shall meet the requirements of MIL-STD-461.
- 3.2.1.12.2(R)<u>Test Method</u>. Controllers shall be tested as specified in MIL-STD-461.
- 3.2.1.13 Removal Time To Reset
- 3.2.1.13.1 Requirement. When tested as specified, the controller shall not reset when the control signal is removed for a time duration less than the minimum time specified (5.0 milliseconds) and reapplied. The controller shall reset when the control signal is removed for the maximum time specified (20 milliseconds) or longer and reapplied.
- 3.2.1.13.2(R)<u>Test Method</u>. Connect the controller as shown in Figure 1. Apply rated supply voltage and adjust the load resistance for 200 ± 10 percent rated load. Adjust control function generator for rated control voltage. Apply control signal and observe that the controller turns ON and trips out. Apply reset signal, and observe that the controller resets.

Follow this same procedure, except the reset signal shall be applied for a time duration less than the minimum specified time. Observe that the controller does not reset. Apply a reset signal for longer than the maximum time specified. Observe that the controller does reset. Record all results on a Pass/ Fail basis.

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- 3.2.1.14 Trip Free Characteristics
- 3.2 1.14.1 <u>Requirement</u>. When tested as specified, the controller shall reset, trip out, and stay tripped out for the duration of the test.

3.2.1.14.2(R)<u>Test Method</u>. With the controller connected as shown in Figure 1, apply rated voltage, adjust load resistor for short circuit, and apply rated control voltage. Observe the controller trips out. Reset the controller by removing rated control voltage. Maintain no control voltage for one minute and verify that the controller resets only once.

3.2.1.15 Fail-Safe (10 Amp HCPC)

- 3.2.1.15.1 Requirement. The controllers shall incorporate a "fail-safe" feature in the event the "trip circuit" fails to perform its function during an overload condition. When tested as specified, the Fail-Safe element (fuse) shall open the circuit between 2 seconds and 20 seconds for an overcurrent of 40 amperes and between 0.1 seconds and 1 second for an overcurrent of 250 amperes.
- 3.2.1.15.2(R)<u>Test Method</u>. An HCPC must be constructed with the "pass sections" intentionally shorted with no more than 0.05 ohms across any solid state device. Connect the shorted power controller as shown in Figure 1. Adjust load resistors for 40 amperes and 250 amperes. Apply rated supply voltage and record time Fail-Safe element takes to clear. Repeat for each value specified.

3.2.1.16 Rupture Capacity

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- 3.2.1.16.1 <u>Requirement</u>. When tested as specified, the controller shall trip and there shall be no damage to the controller. The controller shall be resettable within 10 minutes after each test.
- 3.2.1.16.2(R)<u>Test Method</u>. The controller shall be connected per Figure 1, except that the power source shall be calibrated for the specified rupture current with the power term: als of the controller shorted. The open circuit voltage before application of the rupture current shall be rated voltage. Records of voltage, current and time shall be obtained. The controller shall be subject to the following test sequence.
 - a. Four (4) tests with the controller on before application of the rupture current.
 - b. Four (4) tests with the controller off, rupture circuit completed, and rupture current initiated by the controller being turned on.
 - c. After preceding tests, test dielectric withstanding voltage and 150% trip time.

There shall be sufficient time between rupture tests to allow temperature stabilization.

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3.2.1.17 Temperature - Altitude

- 3.2.1.17.1 <u>Requirement</u>. Controllers shall turn-on, turn-off and trip when overloaded when subjected to the temperature - altitude conditions specified below.
- 3.2.1.17.2(R)<u>Test Method</u>. With the controller connected as shown in Figure 1, test the controller in accordance with Procedure 7, Method 504, of MIL-STD-810. The following details and exceptions shall apply:
 - a. Equipment Category 6
 - b. Test Conditions The minimum and maximum operating temperatures shall be -40° C and $+75^{\circ}$ C, respectively.
 - c. Test Item Operation Full load
 - d. Heat Removal During controller operation, the heat removal apparatus shall be adjusted to allow the case temperature to rise to a maximum of 75° C.
 - e. Inspection after tests shall consist of a visual inspection of the design and construction, a dielectric withstanding voltage test and verification that the controllers turn on with maximum rated current, turns off and trips with an overcurrent.

3.2.1.18 Shock

- 3.2.1.18.1 <u>Requirement</u>. Controllers shall operate satisfactorily during and after exposure to the shock stresses specified below.
- 3.2.1.18.2 <u>Test Method</u>. Controllers shall be connected as shown in Figure 1 and tested in accordance with Procedure IV, Method 516 of MIL-STD-810. The following details and exceptions shall apply:
 - a. Pulse Configuration 50 G for 11 milliseconds
 - b. Electrical Load Conditions In each of the six directions, the controller shall be "ON" full load for the first shock pulse and "OFF" for the second.

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c. (Repeat 3.2.1.17.2 e.)

3.2.1.19 Vibration

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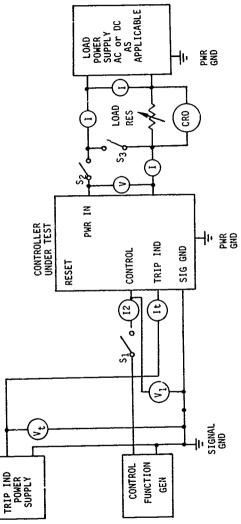
- 3.2.1.19.1 <u>Requirement</u>. Controllers shall operate satisfactorily during and after exposure to the vibration levels specified below.
- 3.2.1.19.2 <u>Test Method</u>. Controllers shall be connected as shown in Figure 1 and tested in accordance with Procedure II, Method 514 of MIL-STD-810. The following details and exceptions shall apply:
 - a. In Part 1, the sinusoidal vibration test curve shown in Figure 4 of this specification shall be used.
 - b. Delete Part 2.
 - c. In Part 3, curve AH shall be used.
 - d. The time schedule of Table 514.2-IV shall be used.
 - e. Inspections during test During the entire vibration schedule, the controller shall be cycled 15 minutes "OFF" and 15 minutes "ON", full load. All parameters shall be monitored continuously.
 - f. Repeat 3.2.1.17.2 e.



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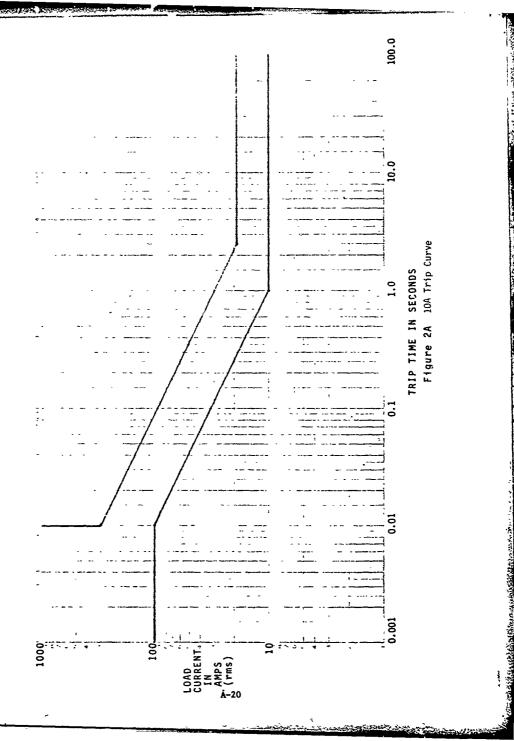
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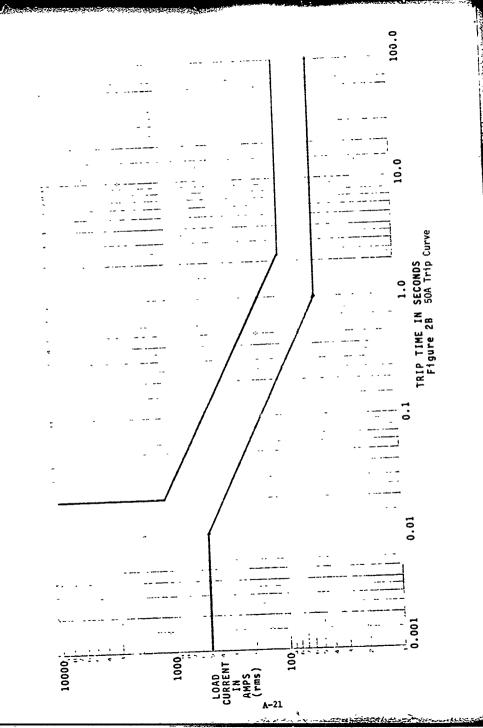
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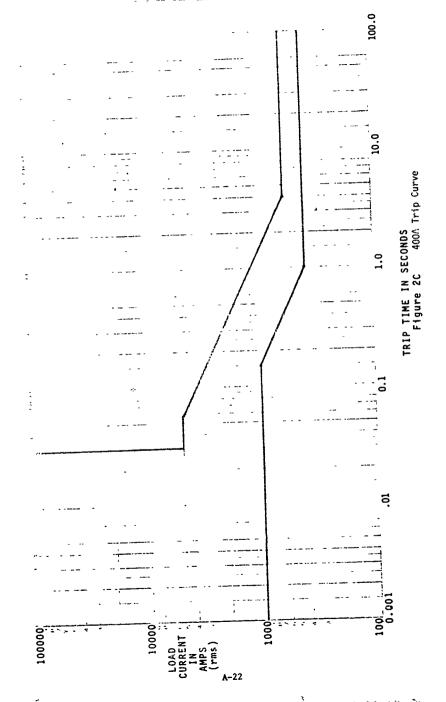
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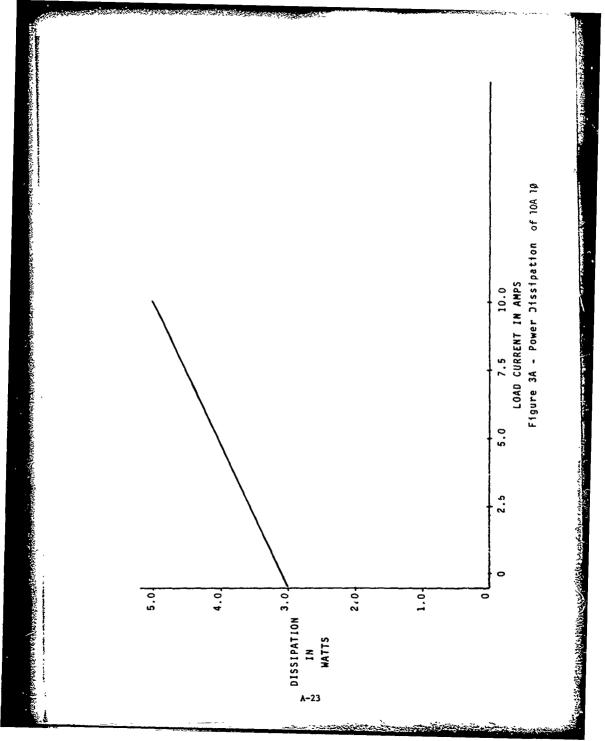


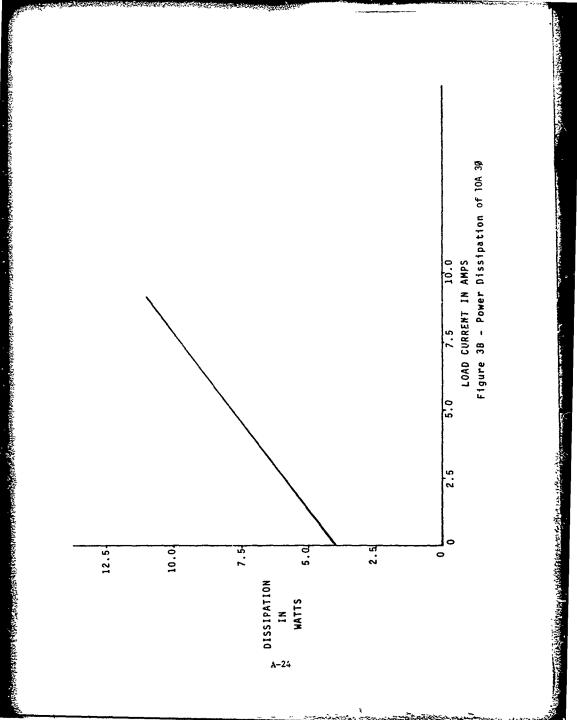
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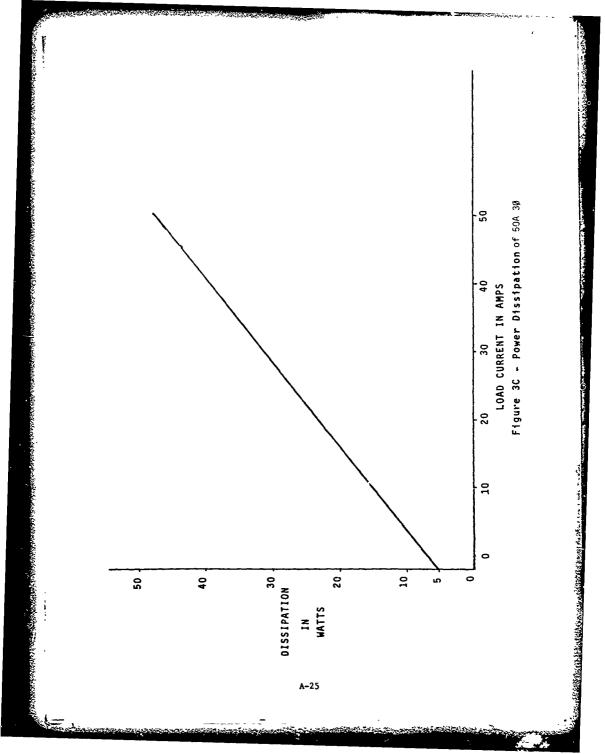


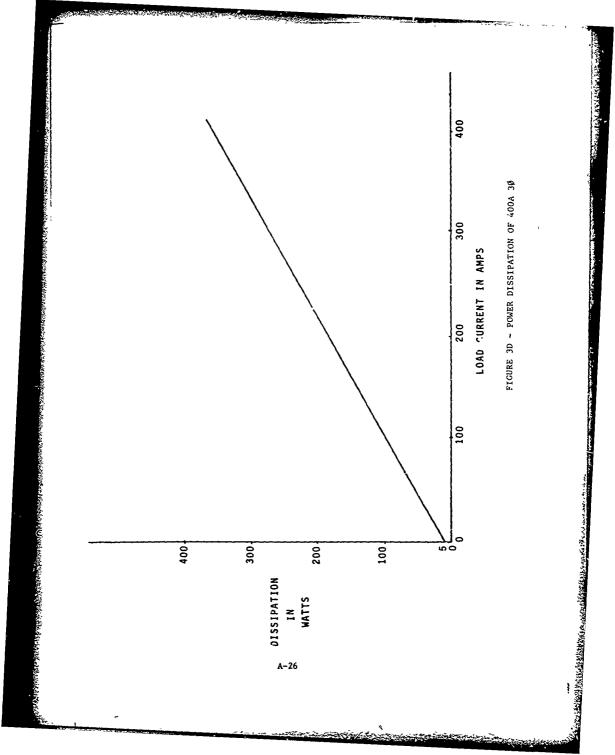
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APPENDIX B RELIABILITY CALCULATIONS

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TABLE 1 PREDICTED RELIABILITY

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SUMMARY

Component	10	10 Amp 1 Phase	07	10 Amp 3 Phase	50	50 Amp 3 Phase	40(400 Amp 3 Phase
Type	አ፤ህ	Σ.11λ	çτγ	γ γ γ μου που μου μου μου μου μου μου μου μου μου μ	γTγ	γ Σο41	qту	λ Ευλι
		The of learning		10 01/0310170	Γ	IU OT/eainite		ratiores/10 Ht
Capacitor	38	0.61640	58	0.93098	58	0.93098	58	0.93098
Resistor	38	16601.0	52	0.12338	56	0.19133	11	0.28985
Diode	22	1.60288	25	1.90368	26	1.96416	26	1.98432
Transistor	12	2.23407	22	3.28926	22	3.28926	24	3.42966
SCR	2	0.80000	6	2.40000	6	4.20000	14	6.24000
10	12	0.75878	12	0.75878	12	0.75878	12	0.75878
Relay	7	0.00703		0.02814	5	0.05628	-	0.05979
Sensor		1.08476	3	3.25428	~	3.25428	ñ	3.25428
Miscellaneous	1	1.09358	21	1.46322	22	1.56322	54	1.85858
TOTAL	137	8.50076	200	14.15167	210	16.20829	234	18.80624
MTBF		117,637 Hr		72,663 Hr		61,697 Hr		\$3,174
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TABLE 2 Predicted reliability

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10A 10

_	Component	P Q	Power Supply	AD	ADC/ LP	sci	SCR Elect	Pac	Package	TOTAL	AL
	Type	QTY	QTY A Failures/10 ⁶ H1	хтγ) Failures/10 ⁶ Hr	QTY	QTY / Failures/106 Hr	qτγ	λ Failures/10 ⁶ Hr	QTY	\ Fallures/l0 ⁶ Hr
	Capacitor	23	0.38921	5	0.06990	10	0.15729			38	0.61640
	Resistor	23	0.07256	80	0.02074	1	0.01001			38	0.10331
	D1.ode	18	1.43784	2	0.28440	~	0.08064			22	1,80288
	Transistor	9	1.64304	-	0.06336	~	0.52762			12	2.23402
	IC	~ 	0.31805	2	0.44073					12	0.75878
	Relay								0.00703	-	0.00703
-	Sensors							~	1 1.08476		1.08476
	Miscellaneous	4	0.65750	7	0.25126	Ś	0.18482			11	1.09358
	scr					7	0.80000			2	0.80000
	TOTAL	67	4.51820	25	1.13039	31	1.76038	2	1.09179	137	8.50076
I								ļ			

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TABLE 3

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PREDICTED RELIABILITY

				10A 3Ø	10A 3Ø					
Component	Ľ	Power Supply	Ν.	ADC/µP	SCR	SCR.Elec () mod)	Ê	Package		TOTAL
Type	dT/	QTMFailure/10 ⁶ Hr	qry	} Fållure/10 ⁶ Hr	γīγ	Å Failure/10 ⁶ Hr	qTY) Failure/10 ⁶ Hr	qτΥ	A Failure/10 ⁶ Hr
Capacitors	23	0.38921	- S	0.06990	30				58	86026.0
Resistors	23	0.07256	~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~	0.02074	21	0.08003	· · · · ·		52	0.17333
Diodes	17	1.37736	2	0.28990	<u>م</u>	0.24192			:7	1.90918
Transistors	ف	1.64304		0.06336	15	1.58286			22	3.28926
IC	ŝ	0.31805	~	0.44073					12	0.75878
Relay							-1	0.08814		0.08814
Sensor							ŝ	3.25428	<u>،</u>	3.25428
Miscellancoun	4	0.65750	7	0.25126	15	0.55446			27	1.40322
SCR					6	2.4000				
TOTAL	78	4.45772	25	1.13039	93	5.28114	4	3.28242	200	14.15167
	ļ									

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PREDICTED RELIABILITY TABLE 4

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50A 3Ø

Component	Pot	Power Supply	ADC/µ	/n	SCF	SCR Elect (3 mod)	Pac	Package	Total	al
Type	QTY	λ Failures/10 ⁶ Hr	QTY	λ Failures/10 ⁶ Hr	ΥŢ	λ Failure/10 ⁶ Hr	QTY	Х Fallure/10 ⁶ Hr	QTY	A Failure/106 Hr
 Capacitor	23	0.38921	Ś	0.06990	8	0.47187			58	0.03098
 Resistor	23	0.07256	ŝ	0.02074	21	0.03003	4	0.06800	56	0.19133
 Diode	18	1.43784	2	0.28490	9	0.24192			26	1.96416
 Transistor	÷	1.64304	-	0.06336	15	1.58286			22	3.28926
 IC	<u>``</u>	0.31805	~	0.44073					12	0.75878
 Relay							7	0.05628	5	0.05628
 Sensor							ŝ	3.25428		3.25428
 Miscellancous	4	0.65750	7	0.25126	15	0.55446	-	0.10000	22	1.56322
 SCR					ę	2.40000	e.	1.80000	9	4.20000
TOTAL	79	4.51820	25	1.13039	63	5.28114	13	5.27856	210	16.20829

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TABLE 5 PREDICTED RELIABILITY

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400A 30

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ŭ	Component	Pot	Power Supply	ADC	ADC/µP	SCH	SCR Elect (3 mod)	Rel	Relay Driver	Pa	Package		TOTAL
	Type	ζIJ	Failure/ 10^6	917	QIY Failure/106	γro	01Y Failure/106	OTY	0TY Fatlure/10 ⁶ 0TY Fat1/10 ⁶	λLO		7.7.0	P
	Capacitor	23	0.38921	~	ł	ĝ						58	0.93098
	Resistor	23	0.07256	~~~~	0.02074	21	0.03003	11	0.03052	~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~	0.13600 71	11	0.28985
	Diode	17	1.37736	7	0.28440	9	0.24192	~	0.08064			26	1.98432
	Transistor	\$	1.64304		0.06336	15	1.58286	~	0.14040			24	3.42966
B(IC	~	0.31805	~	0.44073							12	0.75878
د	Relay									~	1 0.05979	-	0.05979
	Sensor									m	3 3.25428	3	3.25428
	SCR					Ŷ	2.40000	~1	0.24000	ç	6 3.6000	14	6.24000
	Miscellaneous	4	0.65750	~	0.25126	15	0.55446	3	0.29536	-	1 0.10000 24	54	1.85858
	TOTAL	62	4.45772	25	1.13039	93	5.28114	10	0.78692	19	19 7.15007 234 18.80624	234	18.80624

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APPENDIX C

UPDATED HCPC SPECIFICATION SHEETS

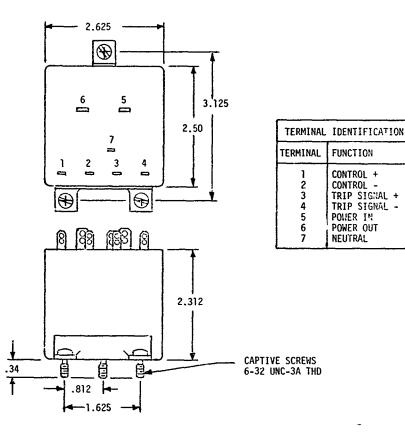
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Specification Sheet

High Current Power Controller

SPST 10A Normally Open

The complete requirements for procuring the controllers described herein shall consist of this document and the latest issue of MIL-P-81653.



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Figure 1. Power Controller Package

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Mechanical Characteristics

Configuration

Dimensions

Enclosure

Weight

Mounting Torque

Terminal Strength Pull Test Bend Test

Thermal Resistance Case-to-sink See Figure 1

Inches

Type 3 (Sealed, other than hermetic)

20.0 ounces

15 in-1b

Condition A, 5 pounds 5 pounds

0.25⁰C/watt with specified mounting torque

 $\frac{Electrical \ Characteristics}{noted} (-40^{\circ}C \ to \ 75^{\circ}C \ Case \ Temperature \ unless \ otherwise \ noted)$

General

Circuit Arrangement Insulation Resistance

Dielectric Withstanding Voltage

Isolation

Life (Operating Cycle)

Radio Interference

Leakage Current

Common Mode Rejection

Power Dissipation On

Power Circuit

Supply Voltage

100 megohms minimum

Applicable

SPST

Applicable

10⁶ minimum

Applicable

1 mA maximum at rated voltage

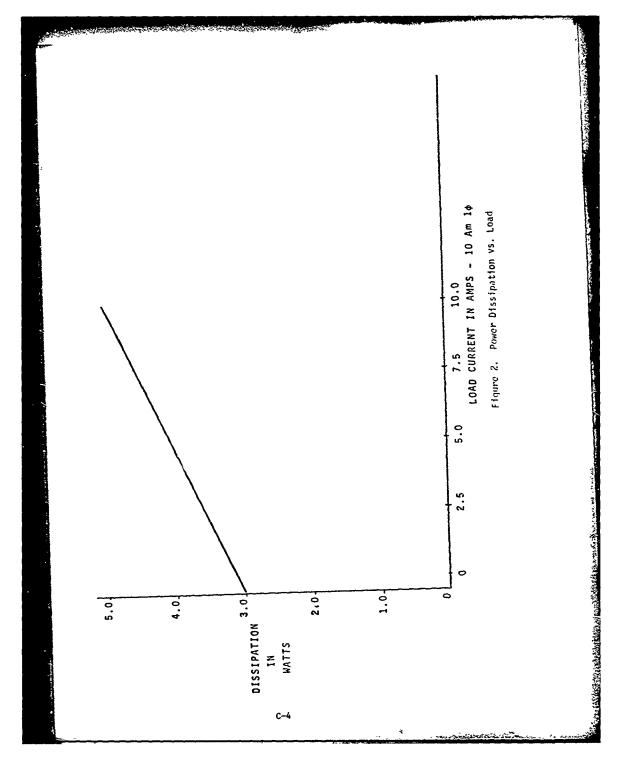
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Application

See Figure 2 3.0 watt maximum

115v nominal per MIL-STD-704



Frequency, rated

Current Limiting

Vdrop

Ripple Current

Rupture Capacity

Overshoot Current

Fail-safe Current

Reset Immunity

Transients Operating Voltage Spike Overvoltage Standby Power

Response Turn-on Time Turn-off Time

Trip Free

Trip Time

Nonrepetitive Reset

Repetition Reset

Trip Indication Signal Tripped

Not Tripped

3-Phase Power Controller

Zero Voltage Turn-on

Zero Current Turn-off

10 amperes

400 Hz <u>+</u> 5%

Not applicable

0.3V maximum

Not applicable

400 ampere minimum

Not applicable

Upper limit of trip curve

Applicable

Applicable Applicable Applicable

15 milliseconds maximum 20 milliseconds maximum

Applicable

See Figure 3

Applicable (2.0 seconds minimum between rescts)

Applicable

 1.5 volts dc maximum, sink 10 mA maximum
 50 microamperes maximum, dc leakage at 30 volts

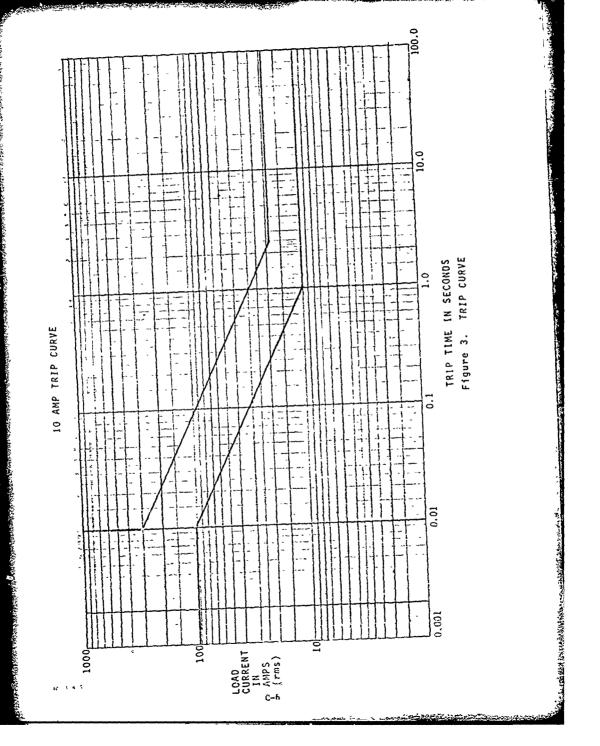
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N/A

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Control Circuit

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Variation of Longs

Supply Voltage

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Turn-on Voltage Rate of Change

Turn-off Voltage Rate of Change

Input Current

Input Transient

Time to Reset Removal

Environmental Characteristics

Case Temperature Operating Storage

Shock Mechanical Temperature

Vibration

Acceleration

Salt Fog

Humidity

Operation at Temperatures Extremc

Temperature Altitude

Operating Ambient Temperature +8.0 Vdc maximum +5.0 Vdc rated

+3.5 Vdc minimum 0.5 volts/microsecond minimum

+2.0 Vdc maximum 0.5 volts/microsecond minimum

10 milliamperes maximum at +5.0 volts rate input voltage

Applicable

5.0 millisecond minimum 20.0 millisecond maximum

 $-40^{\circ}C$ to $+75^{\circ}C$ -65°C to $+100^{\circ}C$

50G for 11 millisecond -54°C and 75°C

Applicable

20G

Applicable

Applicable

Applicable

Applicable

-40°C to 75°C Sea Level to 70,000 feet and a state of the state of the

Specification Sheet

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High Current Power Controller

3PST 10A Normally Open

The complete requirements for procuring the controllers described herein shall consist of this document and the latest issue of MIL-P-81653.

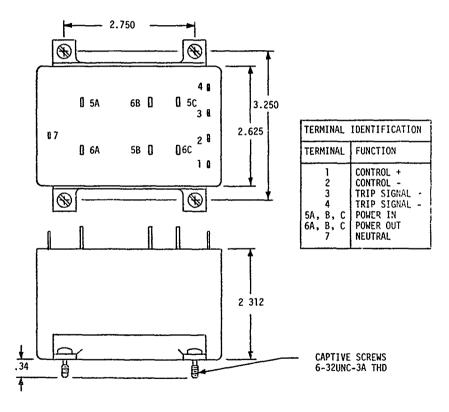


Figure 1. Power Controller Package

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Mechanical Characteristics

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Configuration

Dimensions

Enclosure

Weight

Mounting Torque

Terminal Strength Pull Test Bend Test

Thermal Resistance Case-to-sink See Figure 1

Inches

Type 3 (Sealed, other than hermetic)

31.0 ounces

15 in-lb

Condition A, 5 pounds 5 pounds

0.25⁰C/watt with specified mounting torque

Electrical Characteristics (-40°C to 75°C Case Temperature unless otherwise noted)

General

Circuit Arrangement

Dielectric Withstanding Voltage

Isolation

Life (Operating Cycle)

Radio Inte, ference

Leakage Current per phase

Common Mode Rejection

Power Dissipation On

Power Circuit

Supply Voltage

100 megohms minimum

Applicable

3PST

Applicable

10⁶ minimum

Applicable

1 mA maximum at rated voltage

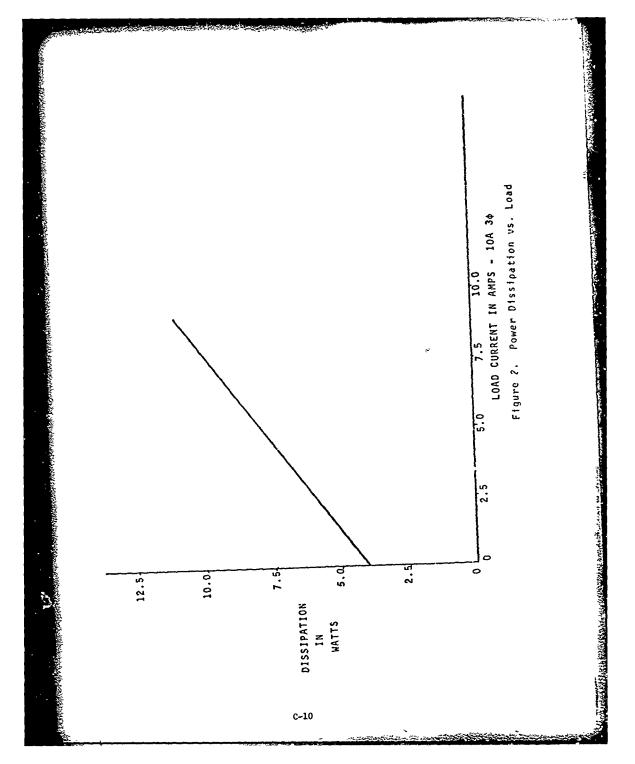
Application

See Figure 2 4.0 watt maximum

115v nominal per MIL-STD-704

Section States

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Current

Frequency, rated

Current Limiting

Vdrop

survey assessed and the star of the design of the start o

Ripple Current

Rupture Capacity

Overshoot Current

Fail-safe Current

Reset Immunity

Transients

Operating Voltage Spike Overvoltage Standby Power

Response Turn-on Time Turn-off Time

Trip Free

Trip Time

Nonrepetitive Reset

Repetition Reset

Trip Indication Signal Tripped

Not Tripped

3-Phase Power Controller

Zero Voltage Turn-on

Zero Current Turn-off

10 amperes per phase 400 Hz ± 5% Not applicable 0.3V maximum per phase Not applicable 400 ampere minimum per phase Not applicable

Upper limit of trip curve

Applicable

Applicable Applicable Applicable

15 milliseconds maximum 20 milliseconds maximum

Applicable

See Figure 3

Applicable (2.0 seconds minimum between resets)

Applicable

 1.5 volts dc maximum, sink 10 mA maximum
 50 microamperes maximum, dc leakage at 30 volts

Overcurrent shall trip all 3 phases Applicable Applicable aparate the state

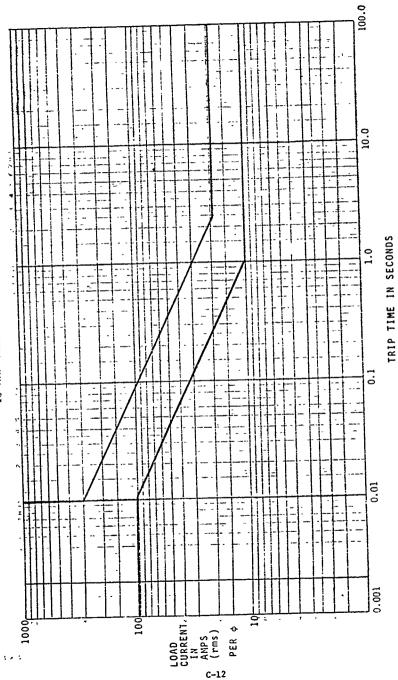
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10 AMP TRIP CURVE

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TRIP CURVE

Figure 3.

Service States and the service of the

Control Circuit

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Supply Voltage

Turn-on Voltage Rate of Change

Turn-off Voltage Rate of Change

Input Current

Input Transient

Time to Reset Removal

Environmental Characteristics

Case Temperature Operating Storage

Shock Mechanical Temperature

Vibration

Acceleration

Salt Fog

Humidity

Operation at Temperatures Extreme

Temperature Altitude

Operating Ambient Temperature #8.0 Vdc maximum +5.0 Vdc rated

+3.5 Vdc minimum 0L5 volts/microsecond minimum

\$2.0 Vdc maximum
0_5 volts/microsecond minimum

10 milliamperes maximum at #5.0 volts rate input voltage

Applicable

5.0 millisecond minimum 20.0 millisecond maximum

-40°C to +75°C -65°C to +100°C

50G for 11 millisecond -54°C and 75°C

Applicable

20G

Applicable

Applicable

Applicable

Applicable

-40°C to 75°C Sea Level to 70,000 feet and the states class, we be used the state of a state of the state of the state of the states of the

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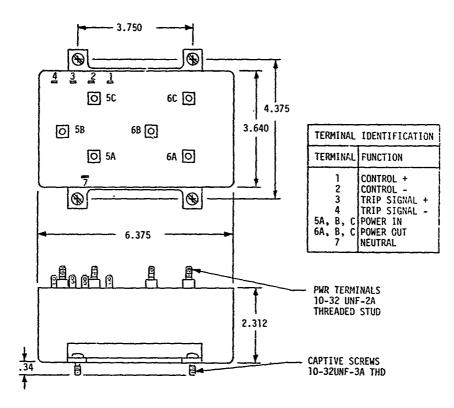
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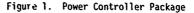
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High Current Power Controller

3PST 50A Normally Open

The complete requirements for procuring the controllers described herein shall consist of this document and the latest issue of MIL-P-81653.





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Mechanical Characteristics

Configuration

Dimensions

Enclosure

Weight

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Mounting Torque

Terminal Strength Pull Test Bend Test

Thermal Resistance Case-to-sink See Figure 1

Inches

Type 3 (Sealed, other than hermetic)

69 ounces

15 in-1b

Condition A, 5 pounds 5 pounds

0.15⁰C/watt with specified mounting torque

Electrical Characteristics $(-40^{9}C \text{ to } 75^{\circ}C \text{ Case Temperature unless otherwise noted})$

General

Circuit Arrangement Insulation Resistance

Dielectric Withstanding Voltage

Isolation

Life (Operating Cycle)

Radio Interference

Leakage Current per phase

Common Mode Rejection

Power Dissipation On

Power Circuit

Supply Voltage

100 megohms minimum

Applicable

3PST

Applicable

10⁶ minimum

Applicable

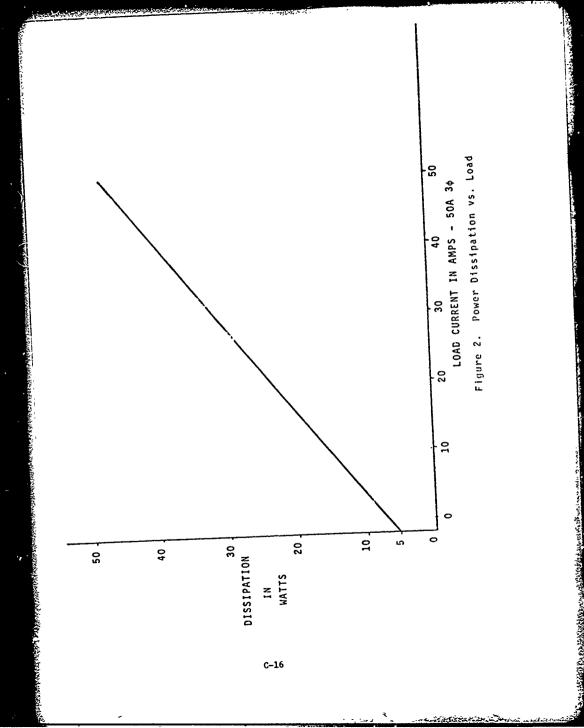
1 mA maximum at rated voltage

Application

See Figure 2 5.0 watt maximum

115v nominal per MIL-STD-704

and the table the transmission and definition to the second of



Current

Frequency, rated

Current Limiting

Vdrop

Ripple Current

Rupture Capacity

Overshoot Current

Fail-safe Current

Reset Immunity

Transients Operating Voltage Spike Overvoltage Standby Power

Response Turn-on Time Turn-off Time

Trip Free

Trip Time

Non: • • tive Reset

Repetition Reset

Trip Indication Signa! Tripped

Not Tripped

3-Phase Power Controller

Zero Voltage Turn-on

Zero Current Turn-off

50 amperes per phase
400 Hz ± 5%
Not applicable
0.3V maximum per phase
Not applicable
2000 ampere minimum per phase
Not applicable
Upper limit of trip curve

Applicable

Applicable Applicable Applicable

15 milliseconds maximum
20 milliseconds maximum

Applicable

See Figure 3

Applicable (2.0 seconds minimum between resets)

Applicable

 1.5 volts dc maximum, , nk 10 mA maximum
 50 microamperes maximum, dc leakage at 30 volts

Overcurrent shall trip all 3 phases

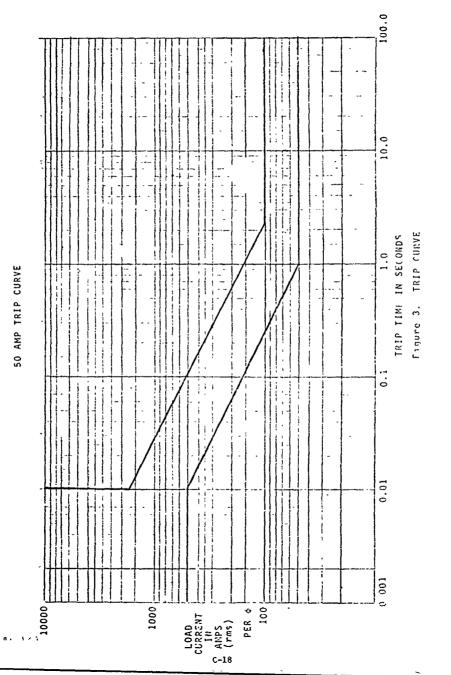
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Applicable

Applicable

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Control Circuit

Supply Voltage

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Turn-on Voltage Rate of Change

Turn-off Voltage Rate of Change

Input Current

Input Transient

Time to Reset Removal

Environmental Characteristics

Case Temperature Operating Storage

Shock Mechanical Temperature

Vibration

Acceleration

Salt Fog

Humidity

Operation at Temperatures Extreme

Temperature Altitude

Operating Ambient Temperature +8.0 Vdc maximum +5.0 Vdc rated

+3.5 Vdc minimum 0.5 volts/microsecond minimum

+2.0 Vdc maximum 0.5 volts/microsecond minimum

10 milliamperes maximum at +5.0 volts rate input voltage

Applicable

5.0 millisecond minimum 20.0 millisecond maximum

-40°C to +75°C -65°C to +100°C

50G for 11 millisecond -54°C and 75°C

Applicable

20G

Applicable

Applicable

Applicable

Applicable

-40°C to 75°C Sea Level to 70,000 feet



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High Current Power Controller

3PST 400A Normally Open

The complete requirements for procuring the controllers described herein shall consist of this document and the latest issue of MIL-P-81653.

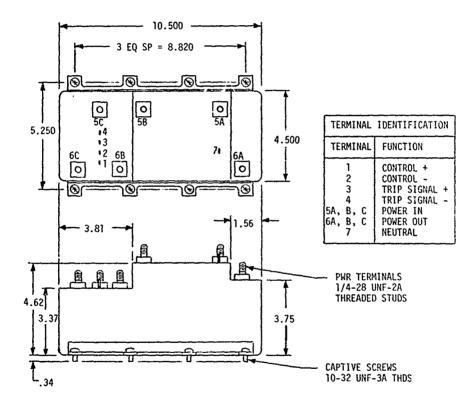


Figure 1. Power Controller Package

Mechanical Characteristics

Configuration

Dimensions

Enclosure

Weight

Mounting Torque

Terminal Strength Pull Test Bend Test

Thermal Resistance Case-to-sink See Figure 1

Inches

Type 3 (Sealed, other than hermetic)

16 pounds

15 in-1b

Condition A, 5 pounds 5 pounds

0.15⁰C/watt with specified mounting torque

Electrical Characteristics (-40°C to 75°C Case Temperature unless otherwise noted)

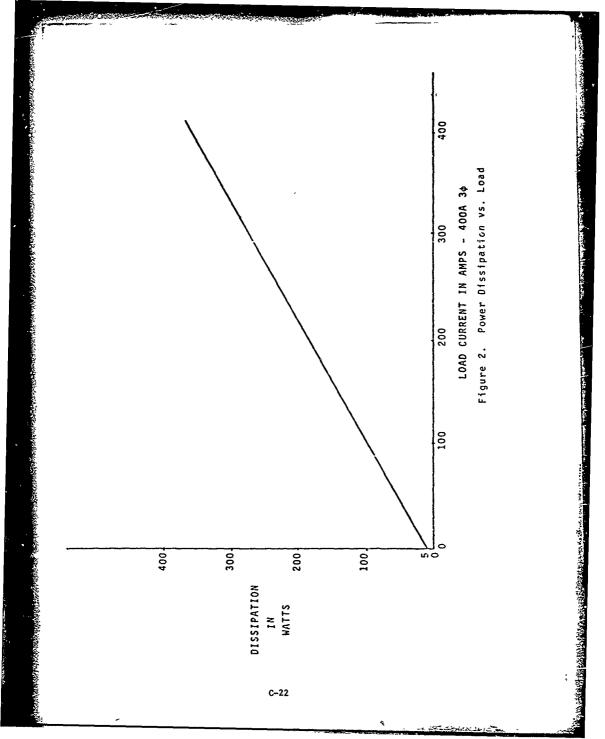
General

3PST Circuit Arrangement 100 megohms minimum Insulation Resistance Applicable Dielectric Withstanding Voltage Applicable Isolation 10⁶ minimum Life (Operating Cycle) Applicable Radio Interference 1 mA maximum at ratee voltage Leakage Current per phase Application Common Mode Rejection See Figure 2 Power Dissipation On 5.0 watt maximum Off **Power Circuit**

Supply Voltage

115v nominal per MIL-STD-704

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Current

Frequency, rated

Current Limiting

Vdrop

Ripple Current

Rupture Capacity

Overshoot Current

Fail-safe Current

Reset Immunity

Transients Operating Voltage Spike Overvoltage Standby Power

Response Turn-on Time Turn-off Time

Trip Free

Trip Time

Nonrepetitive Reset

Repetition Reset

Trip Indication Signal Tripped

Not Tripped

3-Phase Power Controller

Zero Voltage Turn-on

Zero Current Turn-off

400 ampere per phase 400 Hz <u>+</u> 5% Not applicable 0.3V maximum per phase

Not applicable

5000 ampere minimum per phase

Not applicable

Upper limit of trip curve

Applicable

Applicable Applicable Applicable

15 milliseconds maximum 30 milliseconds maximum

Applicable

See Figure 3

Applicable (2.0 seconds minimum between resets)

Applicable

 1.5 volts dc maximum, sink 10 mA maximum
 50 microamperes maximum, dc leakage at 30 volts

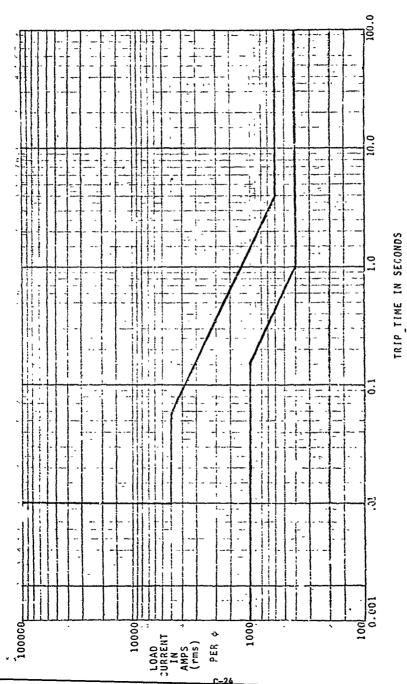
Overcurrent shall trip all 3 phases

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Applicable

Applicable

400 AMP TRIP CURVE



Trip Curve Figure 3. Marken and a Archive Manual Control

Restances in a statistic manufactivity and a state of the second statements for a second statement of a second statement of

Control Circuit

Supply Voltage

Turn-on Voltage Rate of Change

Turn-off Voltage Rate of Change

Input Current

Input Transient

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Time to Reset Removal

Environmental Characteristics

Case Temperature Operating Storage

Shock Hechanical Temperature

Vibration

Acceleration

Salt Fog

Humidity

Operation at Temperatures Extreme

Temperal _ Altitude

Operating Ambient Temperature +8.0 Vdc maximum +5.0 Vdc rated

+3.5 Vdc minimum 0.5 volts/microsecond minimu.

+2.0 Vdc maximum 0.5 volts/microsecond minimum

10 milliamperes maximum at 45.0 volts rate input voitage

Applicable

5.0 millisecond minimum 20.0 millisecond maximum

 -40° C to $+75^{\circ}$ \hat{s} -65°C to $+100^{\circ}$ C

50G for 11 millisecond -54°C and 75°C

Applicable

20G

Applicable

Applicable

Applicable

Applicable

-40°C to 75°C Sea Level to 70,000 feet